

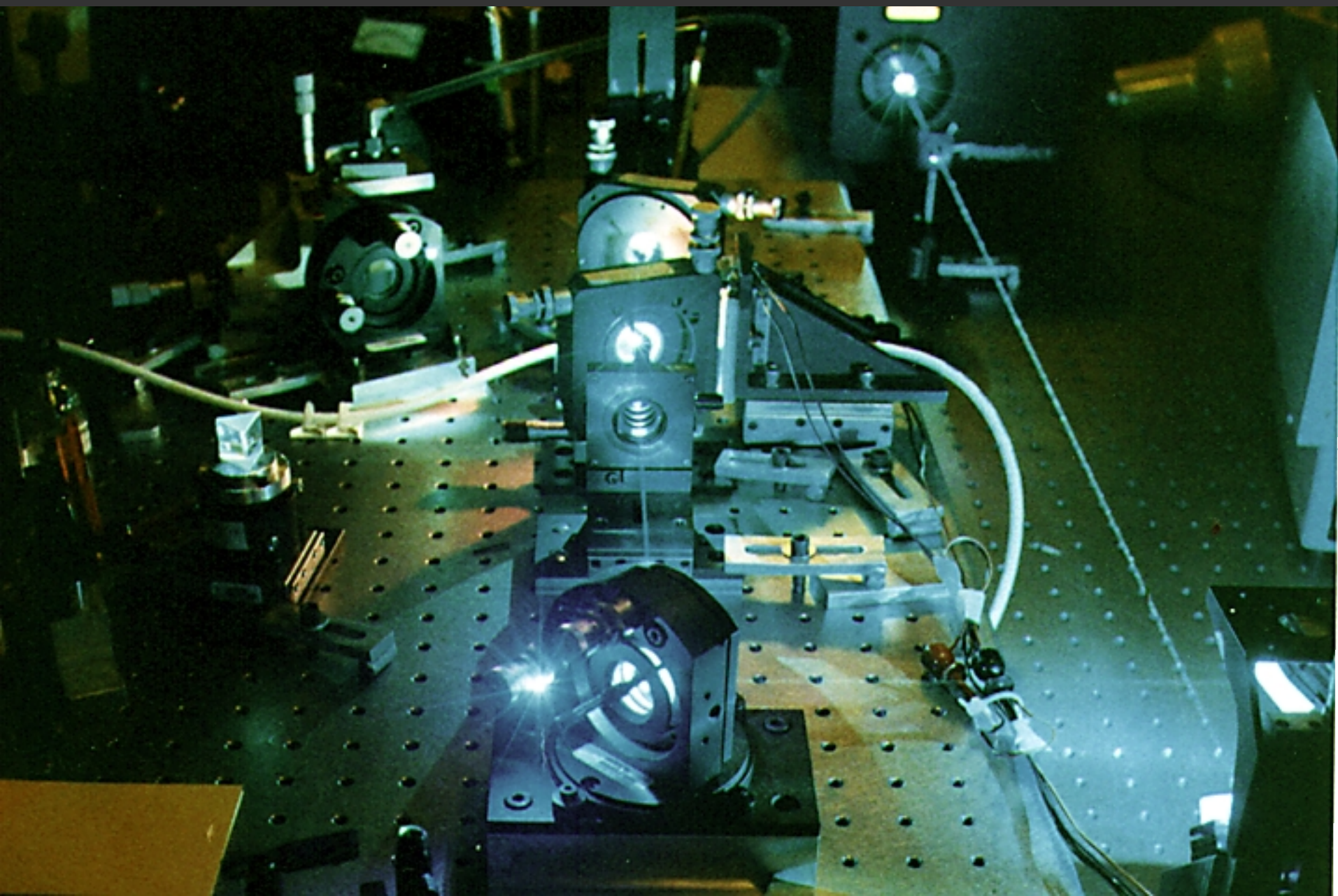
# **Laser-Induced Microexplosions: creating stellar conditions on an optical bench**

**Chris B. Schaffer  
André Brodeur  
José Garcia  
Eric Mazur**

Hong Kong University  
23 October 1999

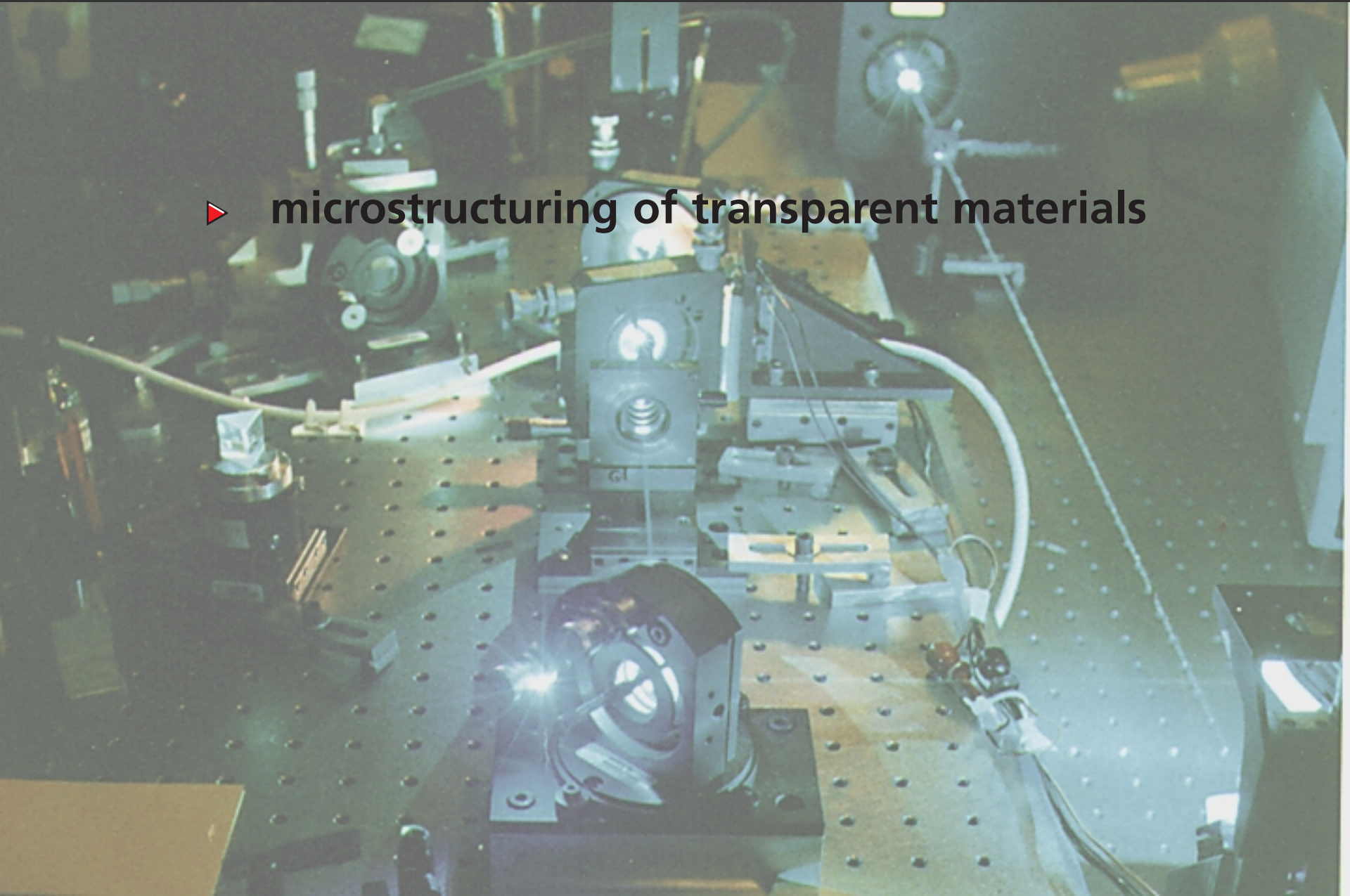


# *Introduction*



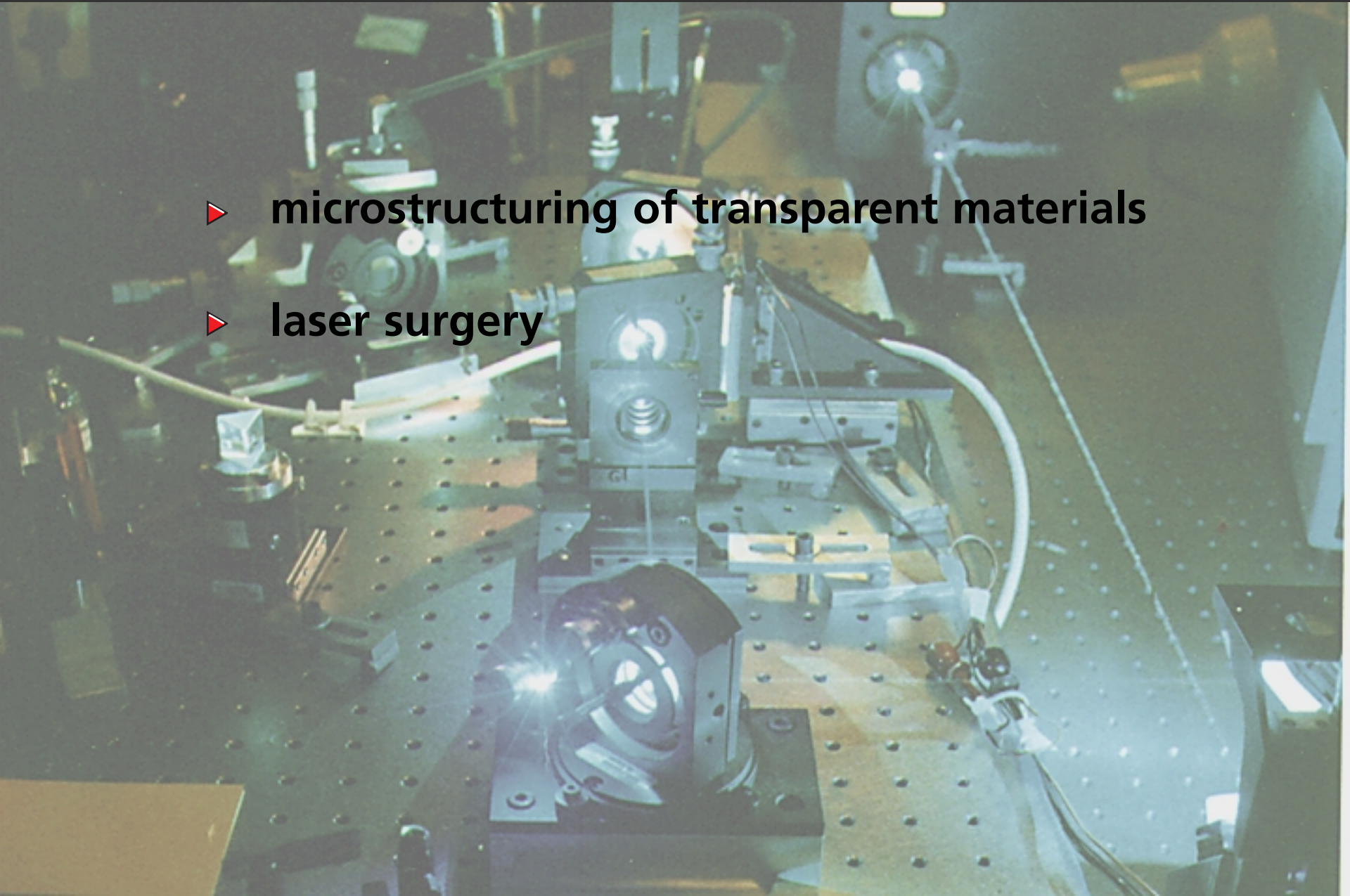
# *Introduction*

- ▶ **microstructuring of transparent materials**



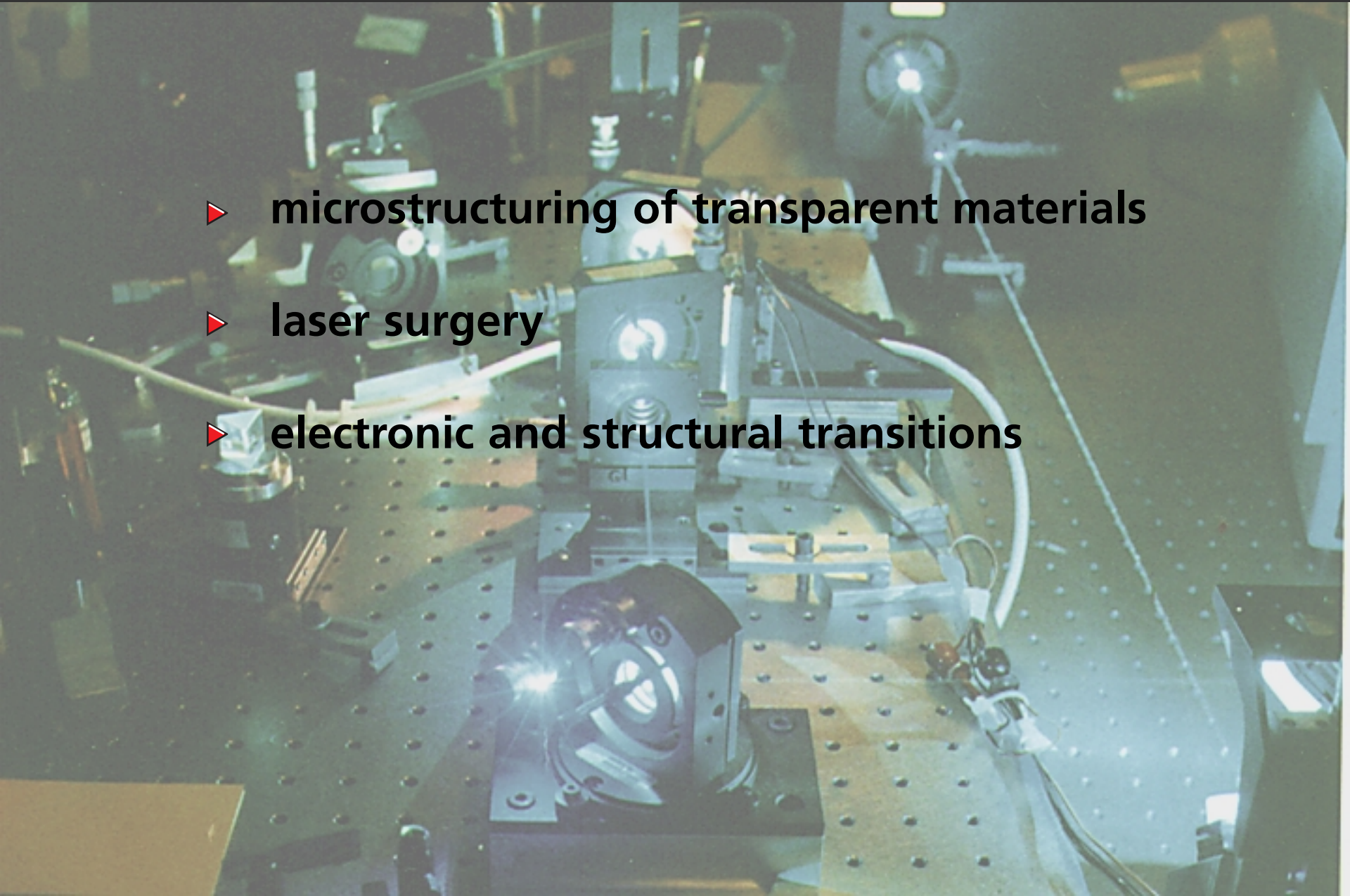
# *Introduction*

- ▶ **microstructuring of transparent materials**
- ▶ **laser surgery**



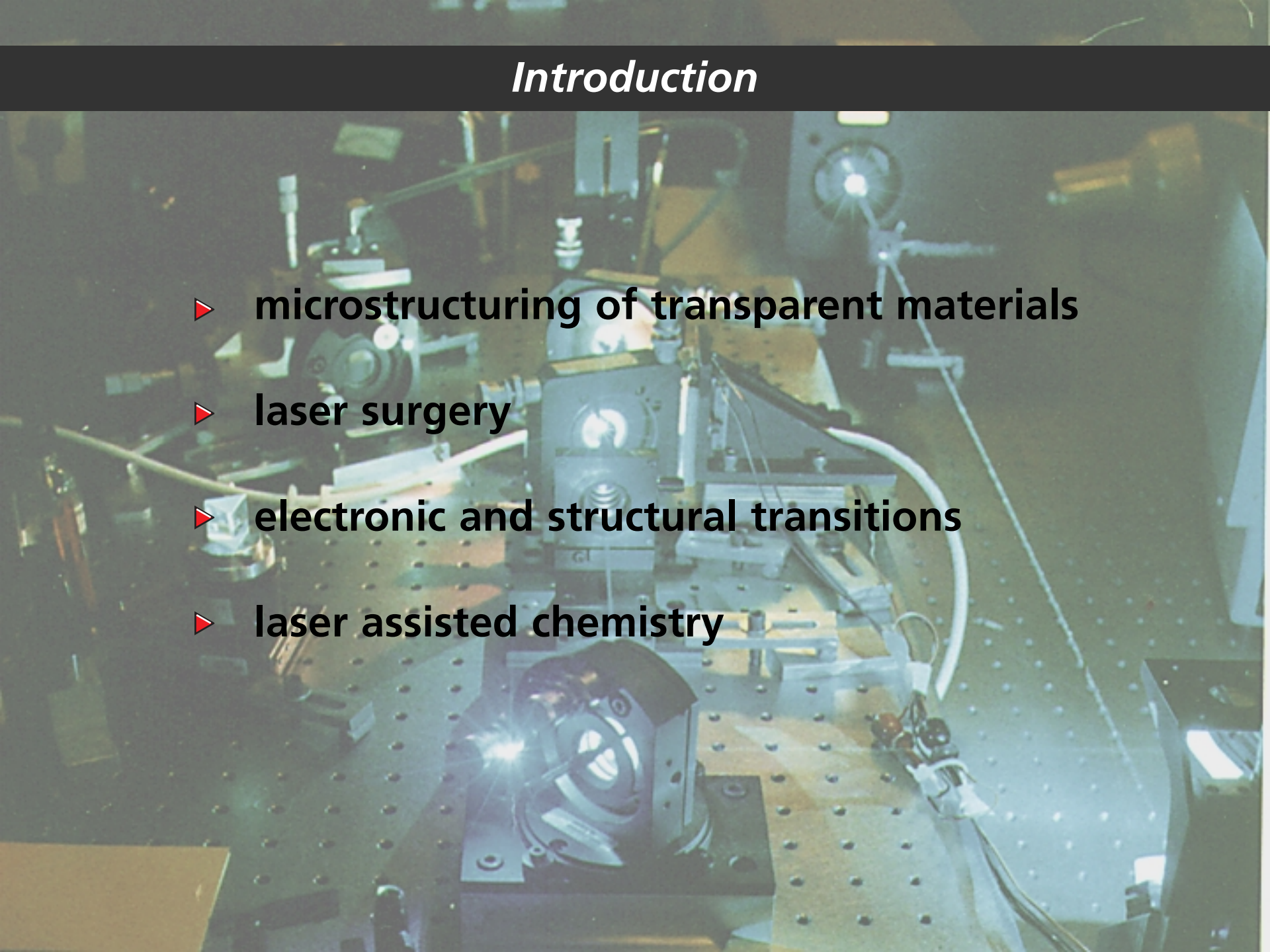
# *Introduction*

- ▶ **microstructuring of transparent materials**
- ▶ **laser surgery**
- ▶ **electronic and structural transitions**

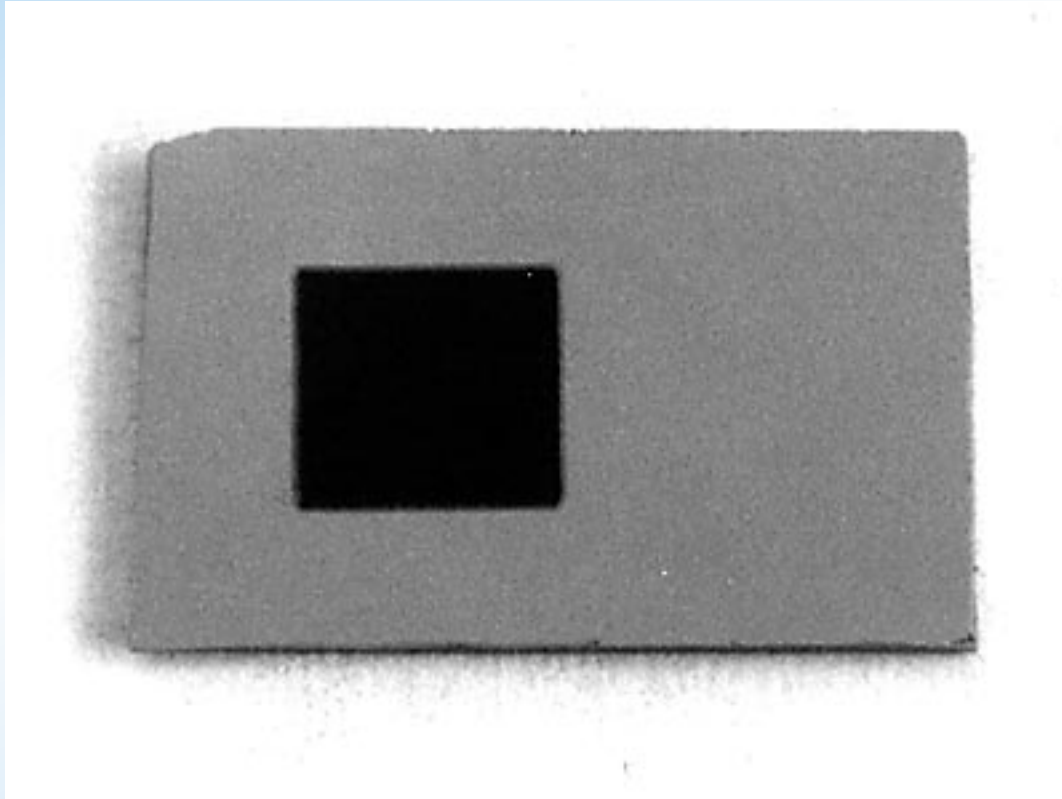


# *Introduction*

- ▶ **microstructuring of transparent materials**
- ▶ **laser surgery**
- ▶ **electronic and structural transitions**
- ▶ **laser assisted chemistry**

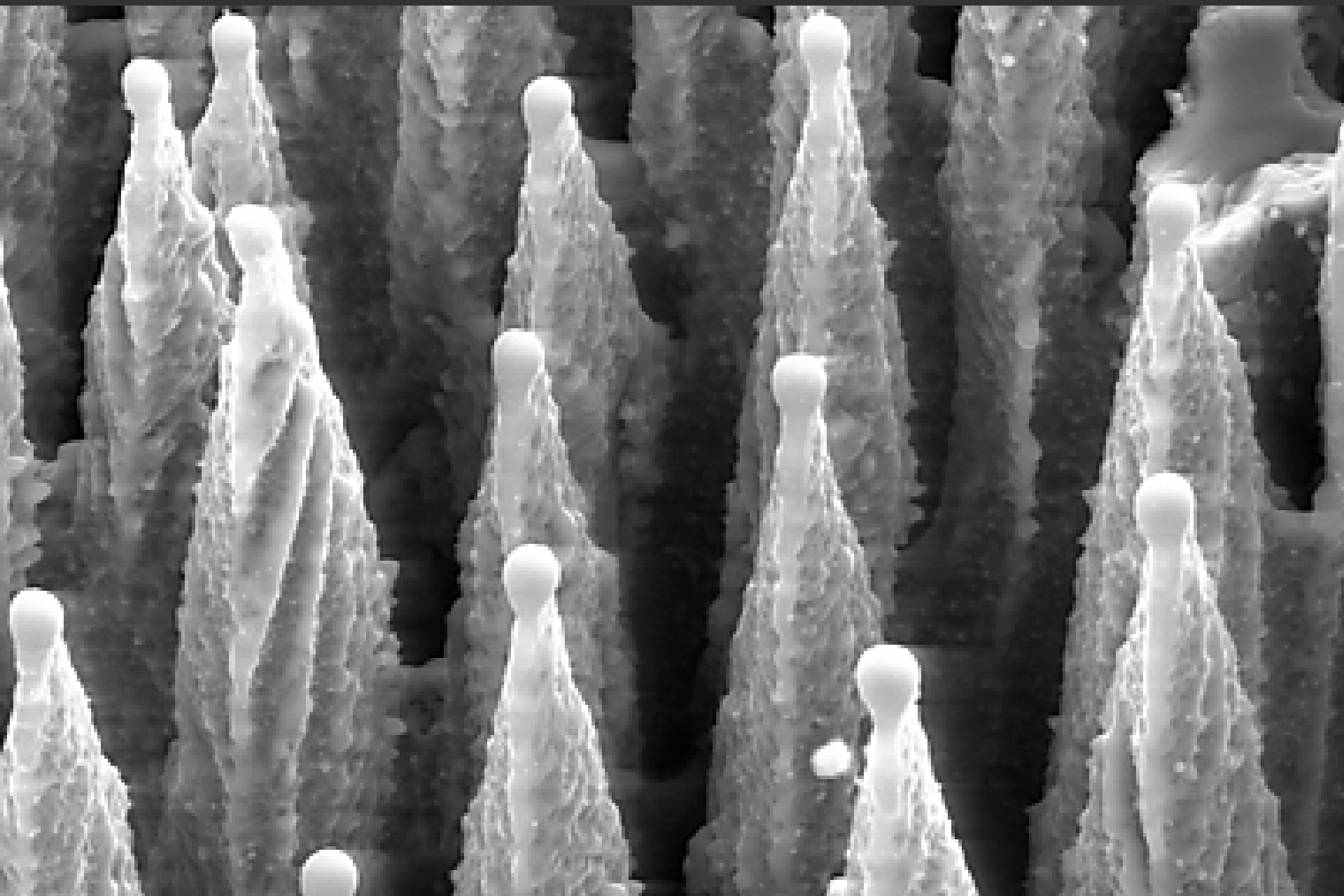


# *Introduction*



5 mm

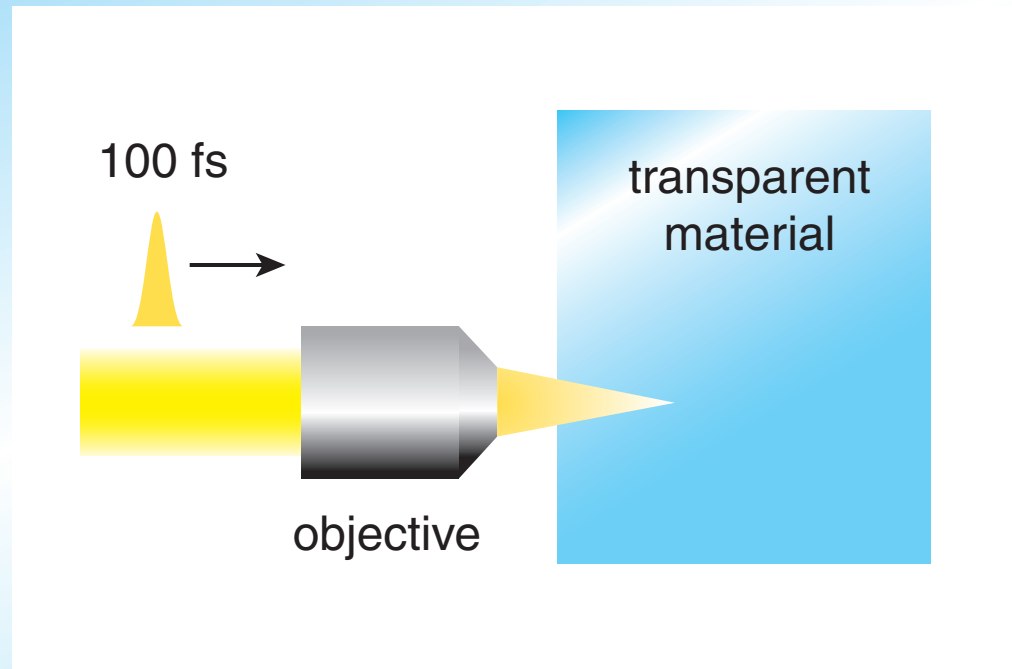
# *Introduction*





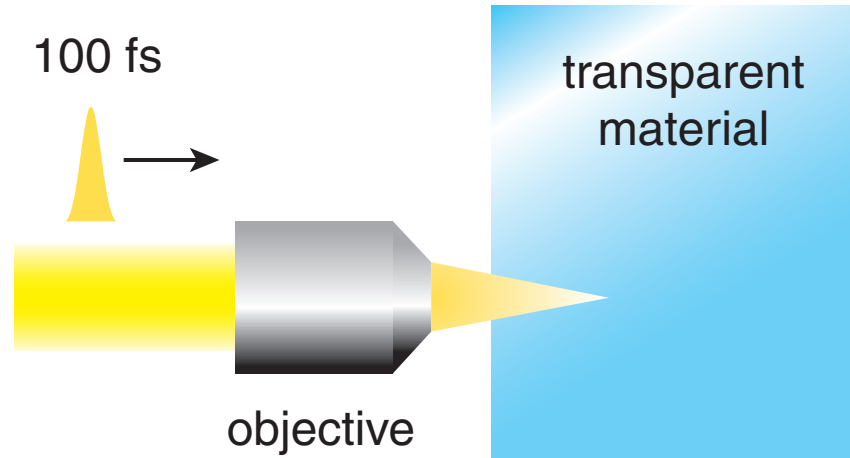
# *Introduction*

**focus laser beam inside material...**



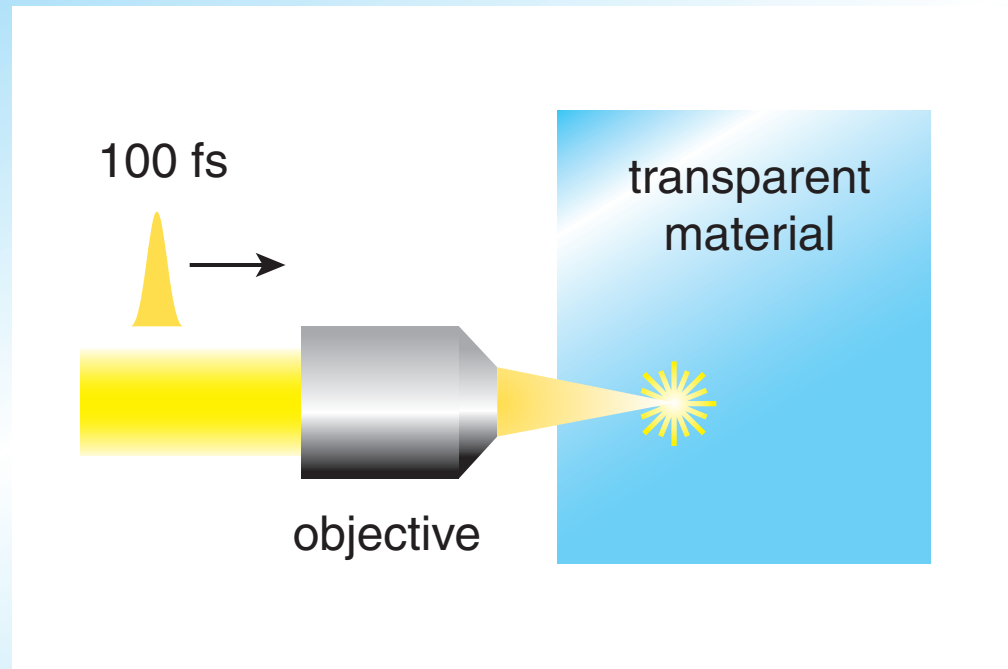
# *Introduction*

**high intensity at focus...**



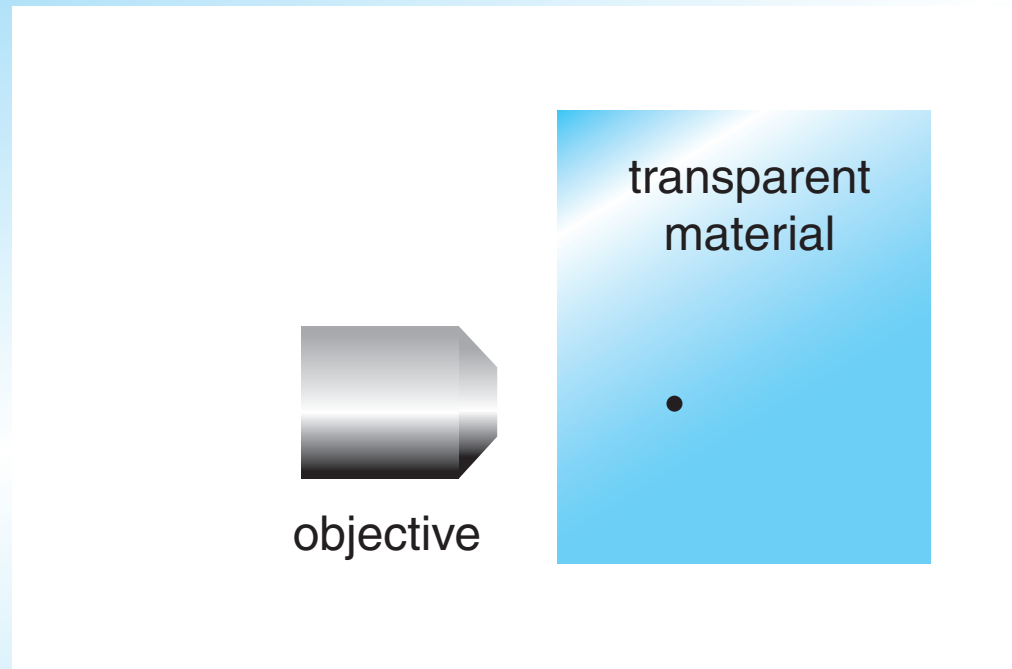
# *Introduction*

**... causes nonlinear ionization...**



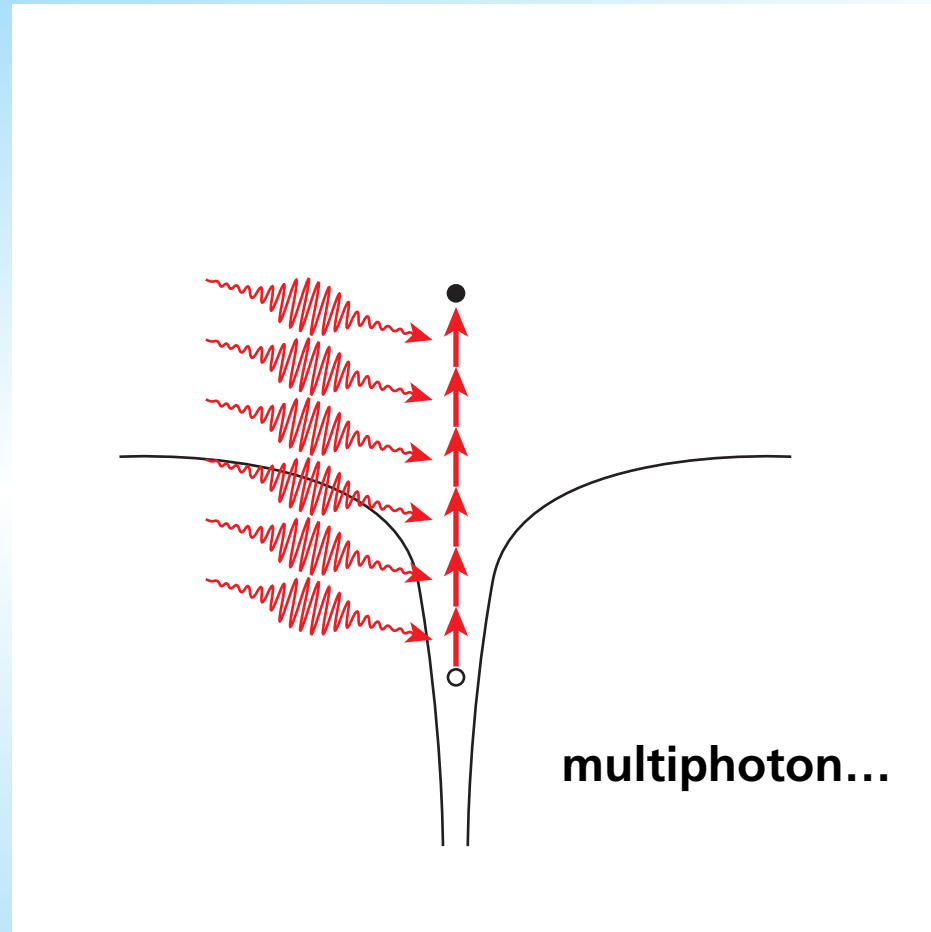
# *Introduction*

**and microscopic bulk damage**



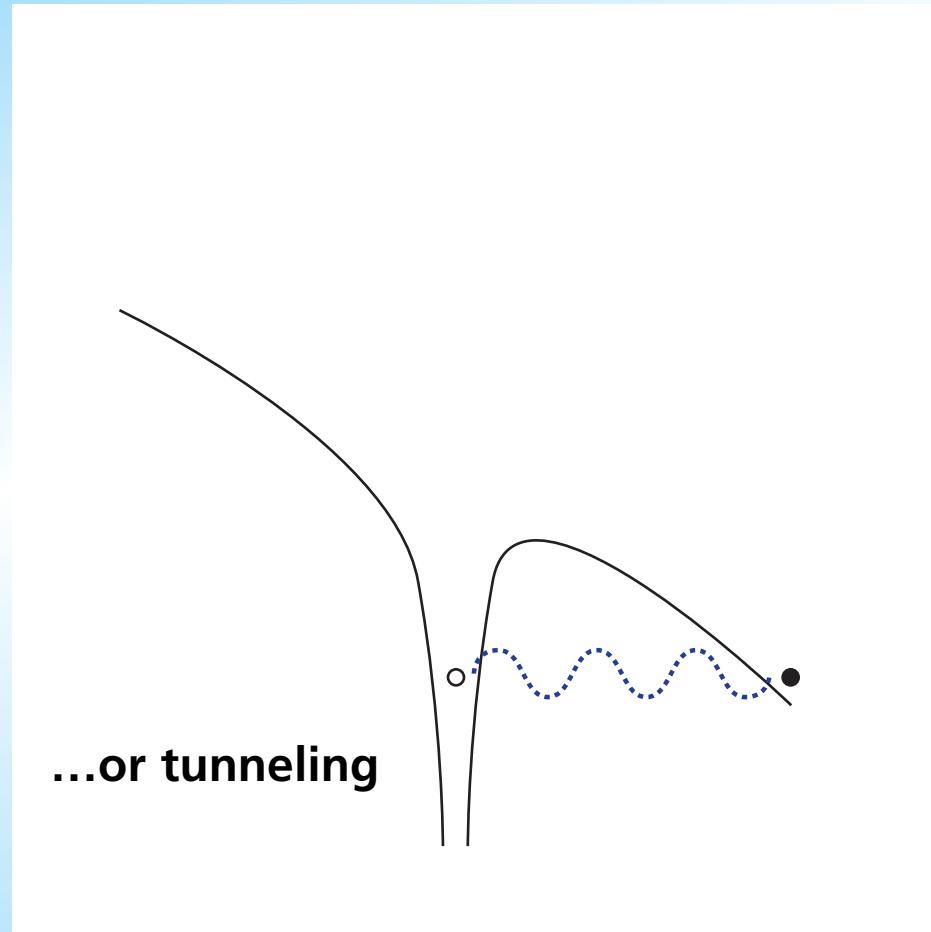
# *Introduction*

## laser field ionization



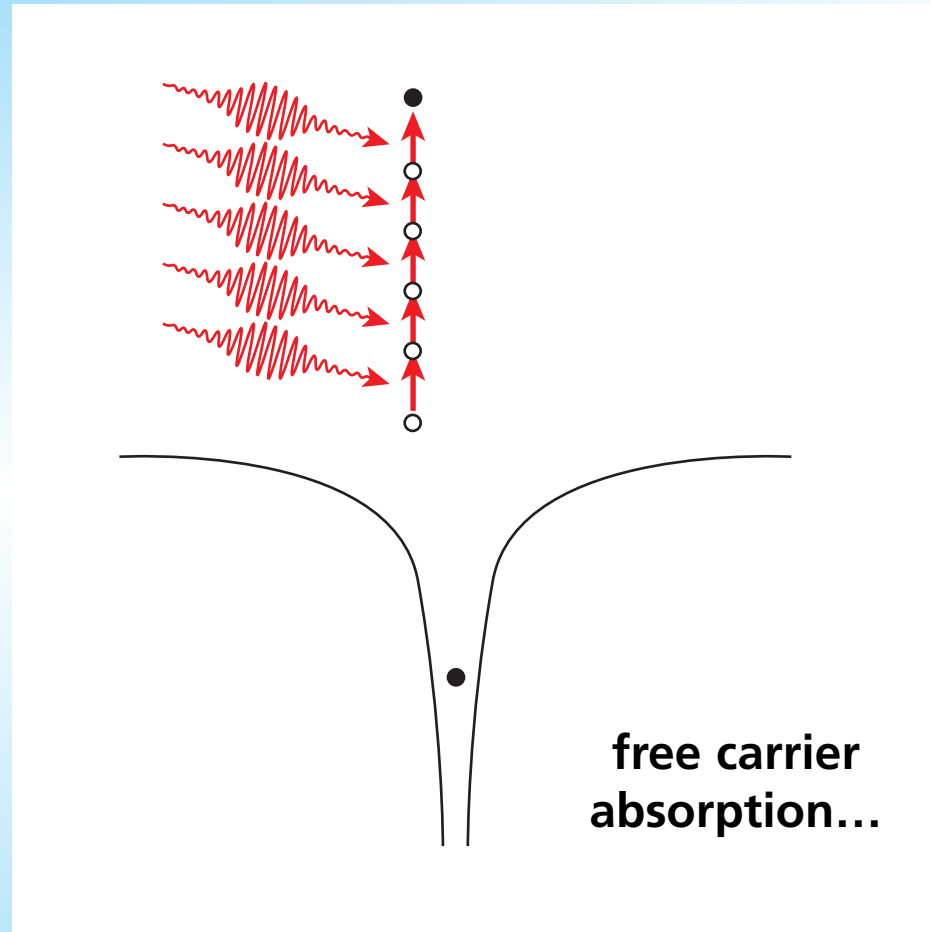
# *Introduction*

## laser field ionization



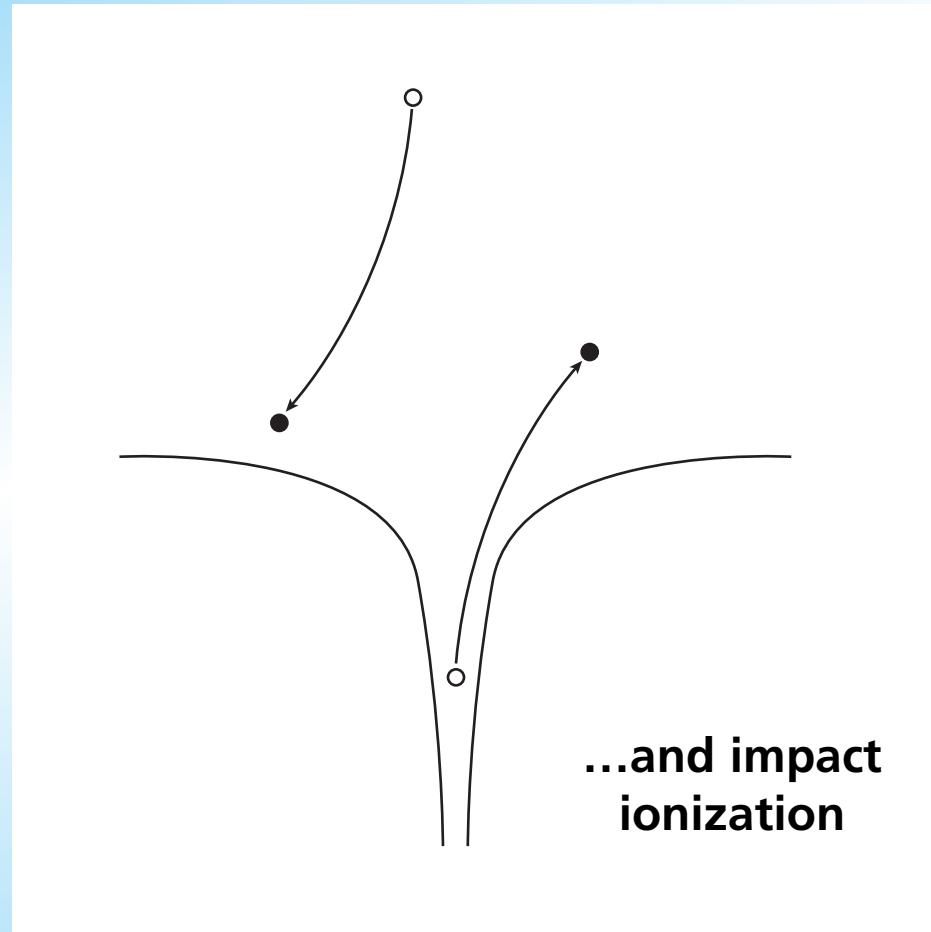
# Introduction

## avalanche ionization



# *Introduction*

## avalanche ionization





# *Introduction*

## **Damage mechanisms:**

- ▶ **explosive**
- ▶ **thermal**
- ▶ **defect forming**

# *Introduction*

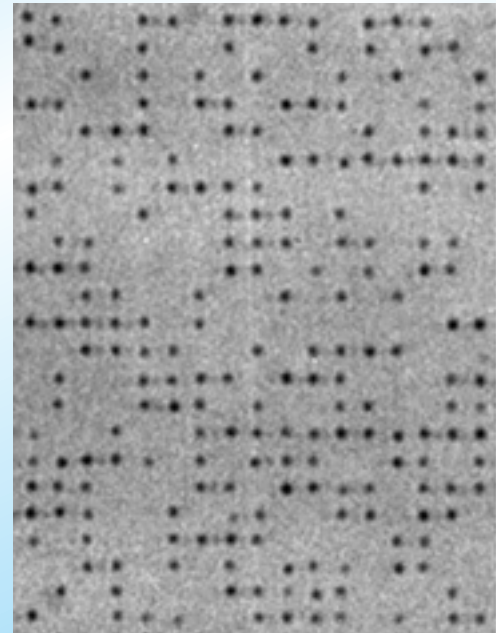
## **Applications:**

- ▶ **data storage**

# *Introduction*

## **Applications:**

- ▶ **data storage**



# *Introduction*

## **Applications:**

- ▶ **data storage**
- ▶ **photonic devices**

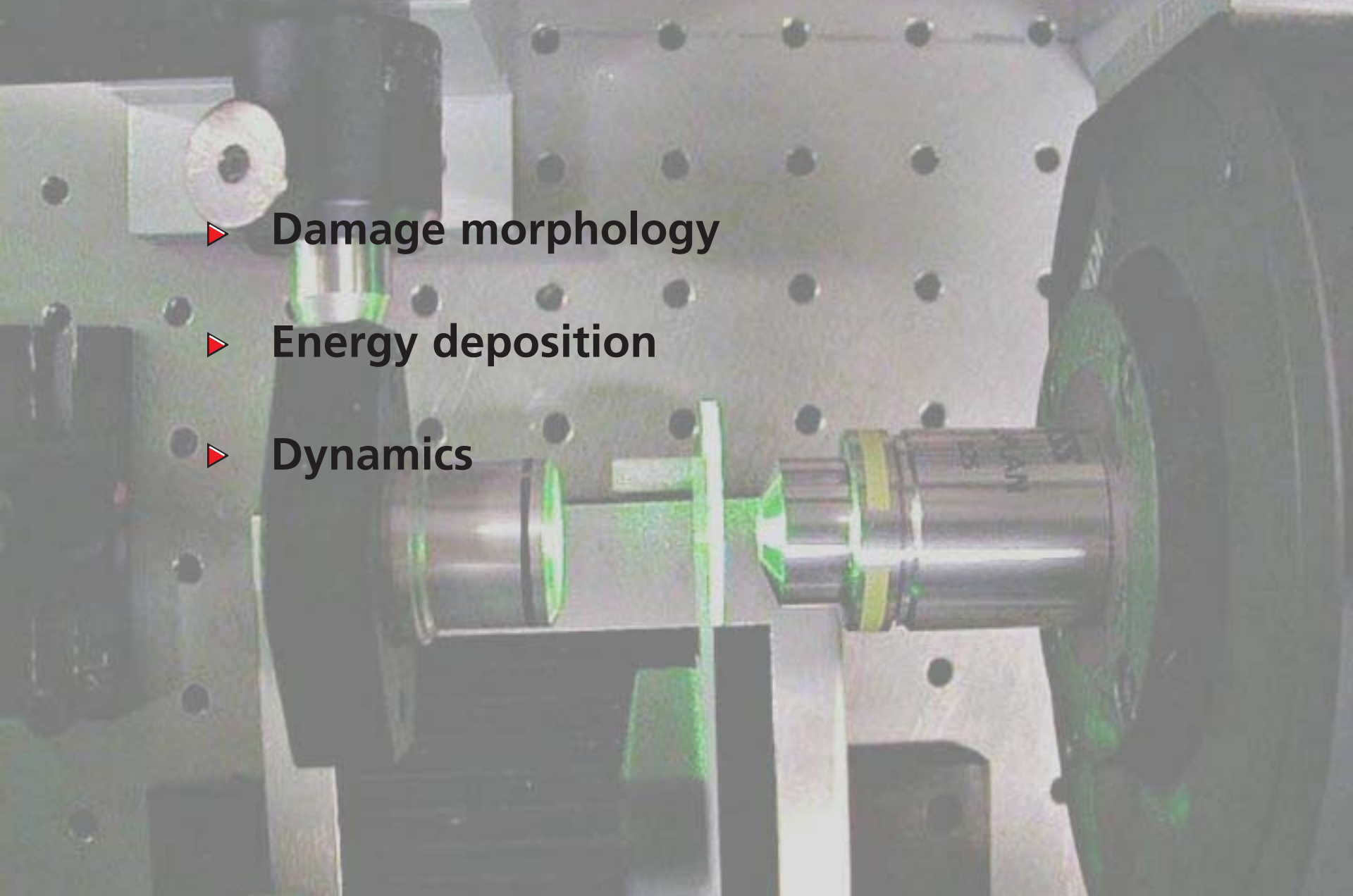
# *Introduction*

## **Applications:**

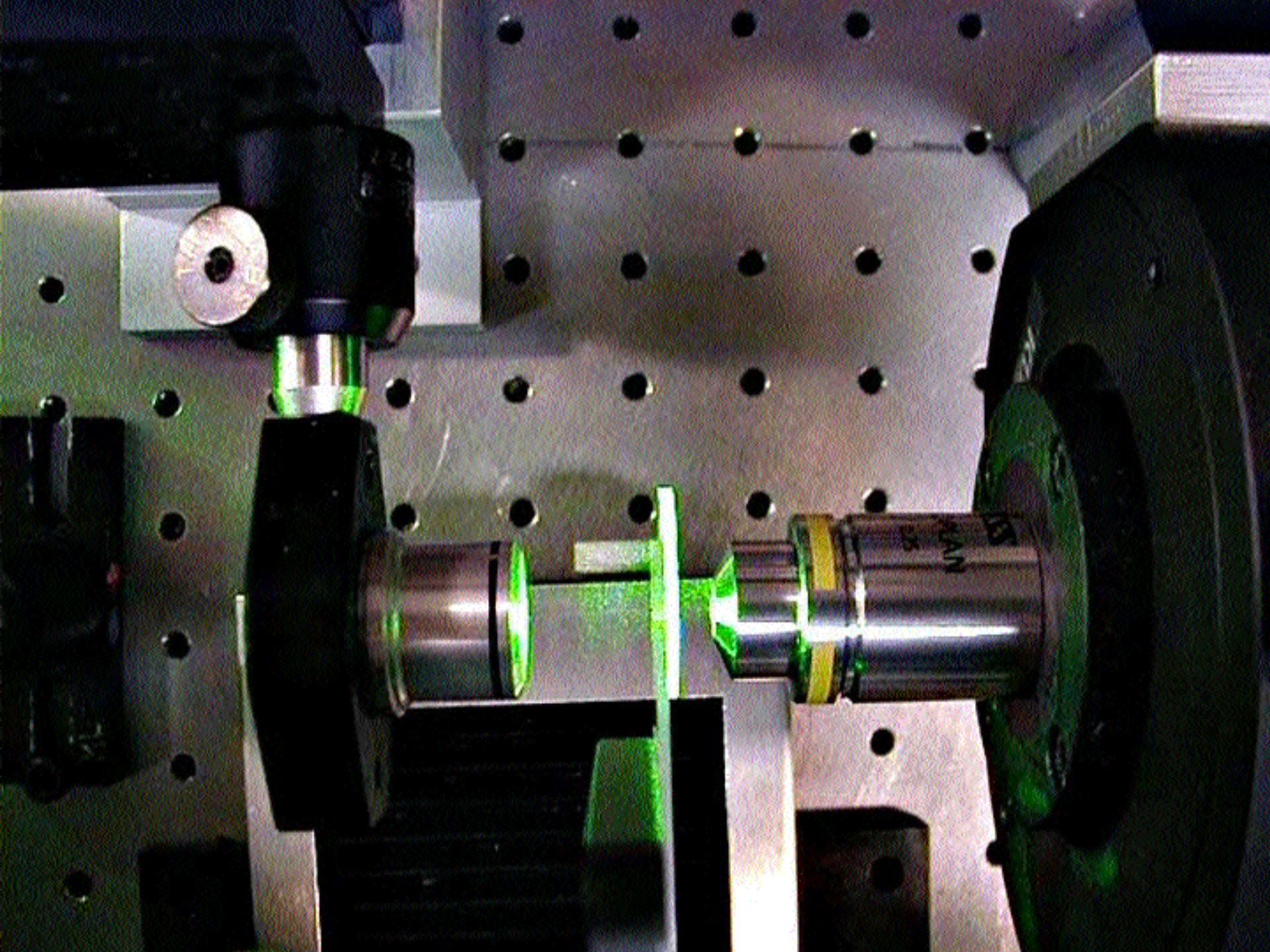
- ▶ **data storage**
- ▶ **photonic devices**
- ▶ **internal micromachining**

# Outline

- ▶ **Damage morphology**
- ▶ **Energy deposition**
- ▶ **Dynamics**

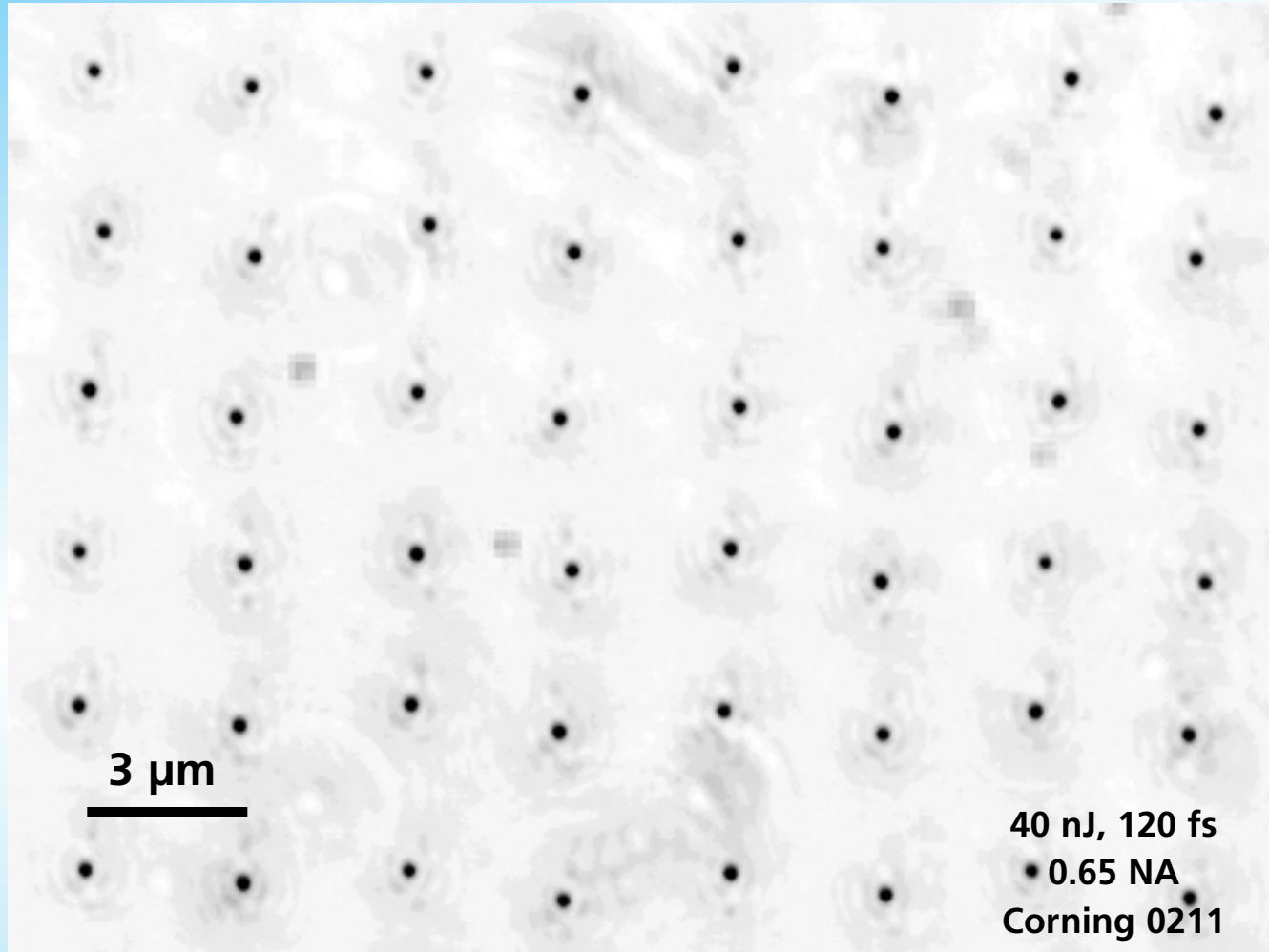




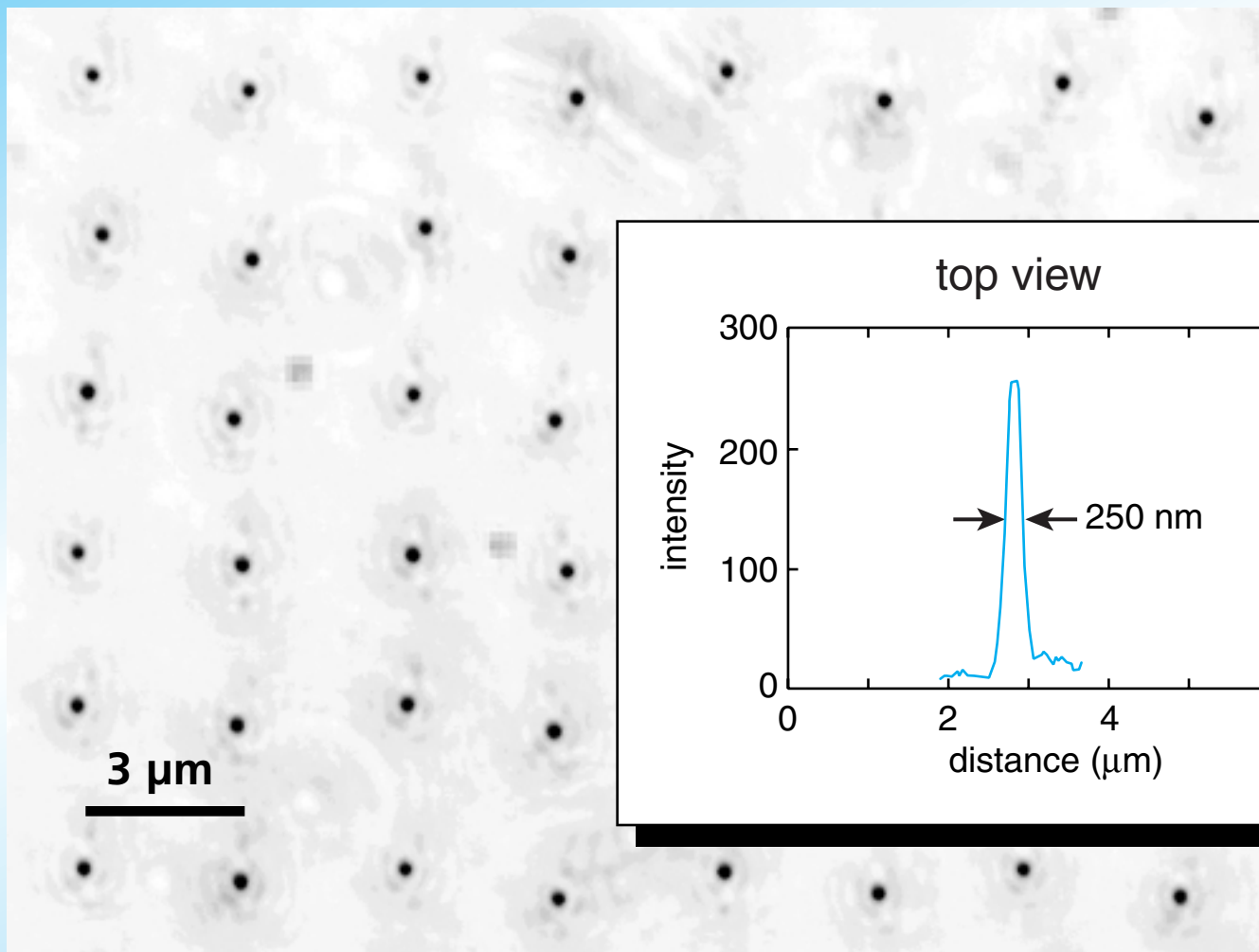




# *Damage morphology*



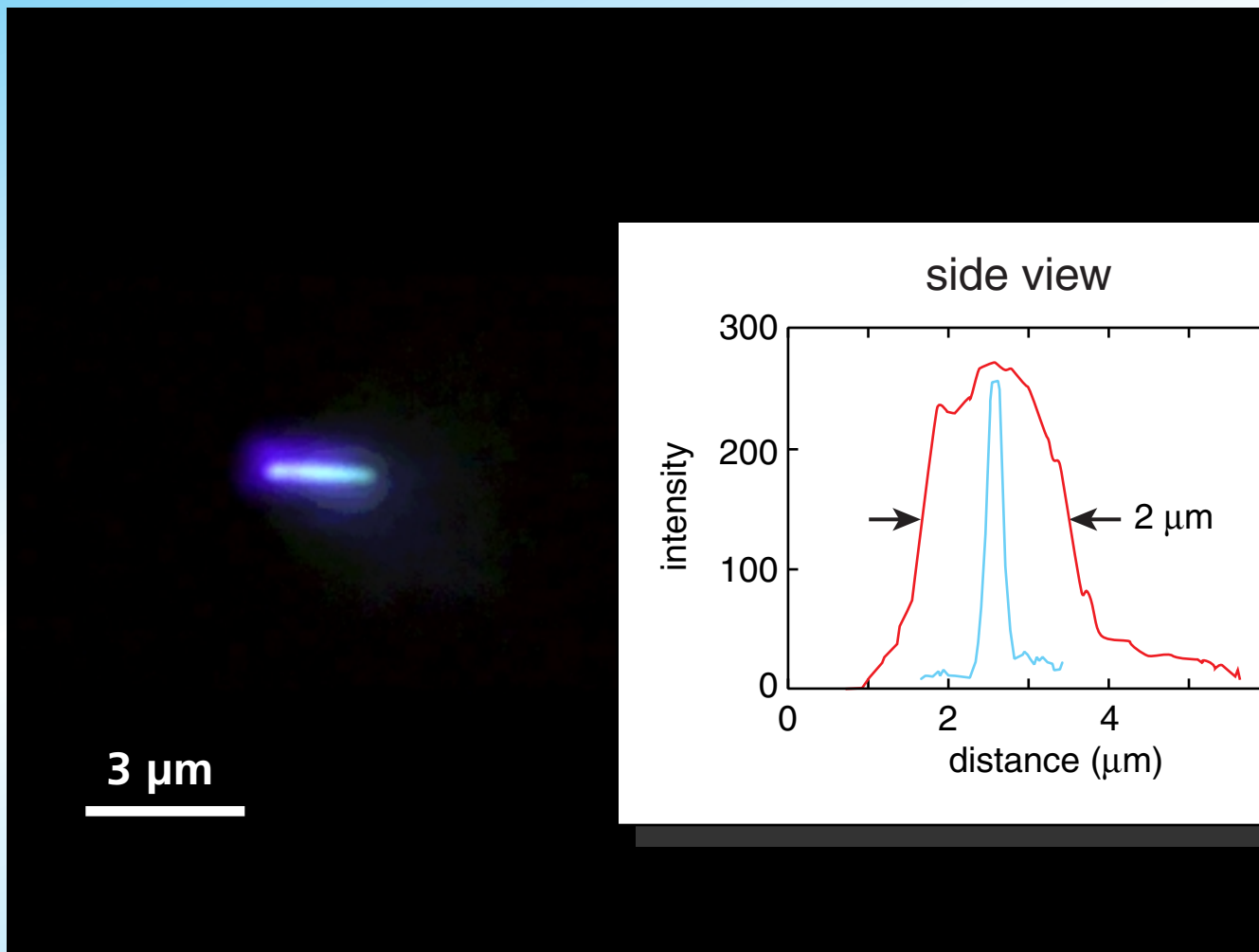
# Damage morphology



# *Damage morphology*



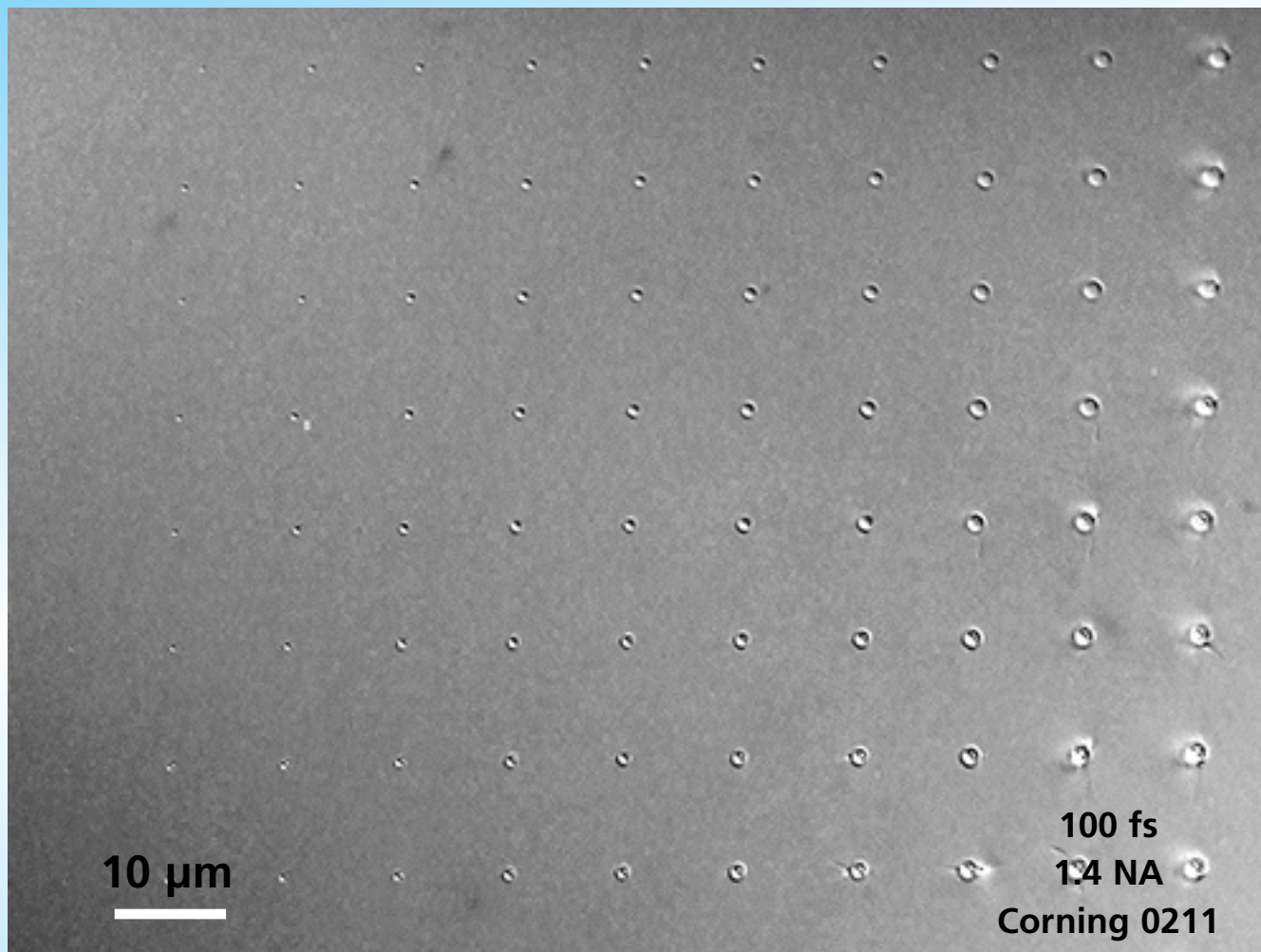
# Damage morphology



# Damage morphology

more energy →

more shots ↓



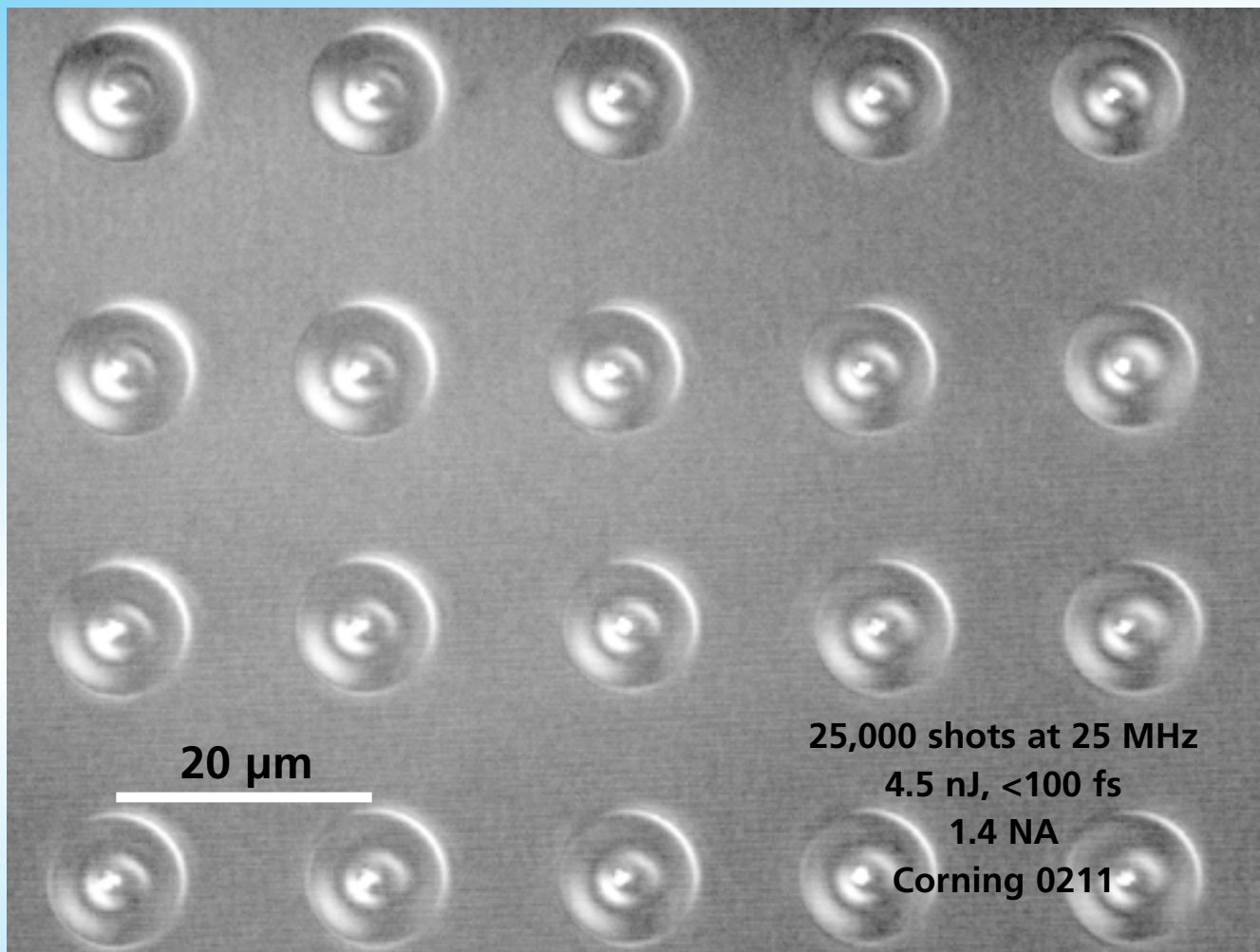
10 μm

100 fs

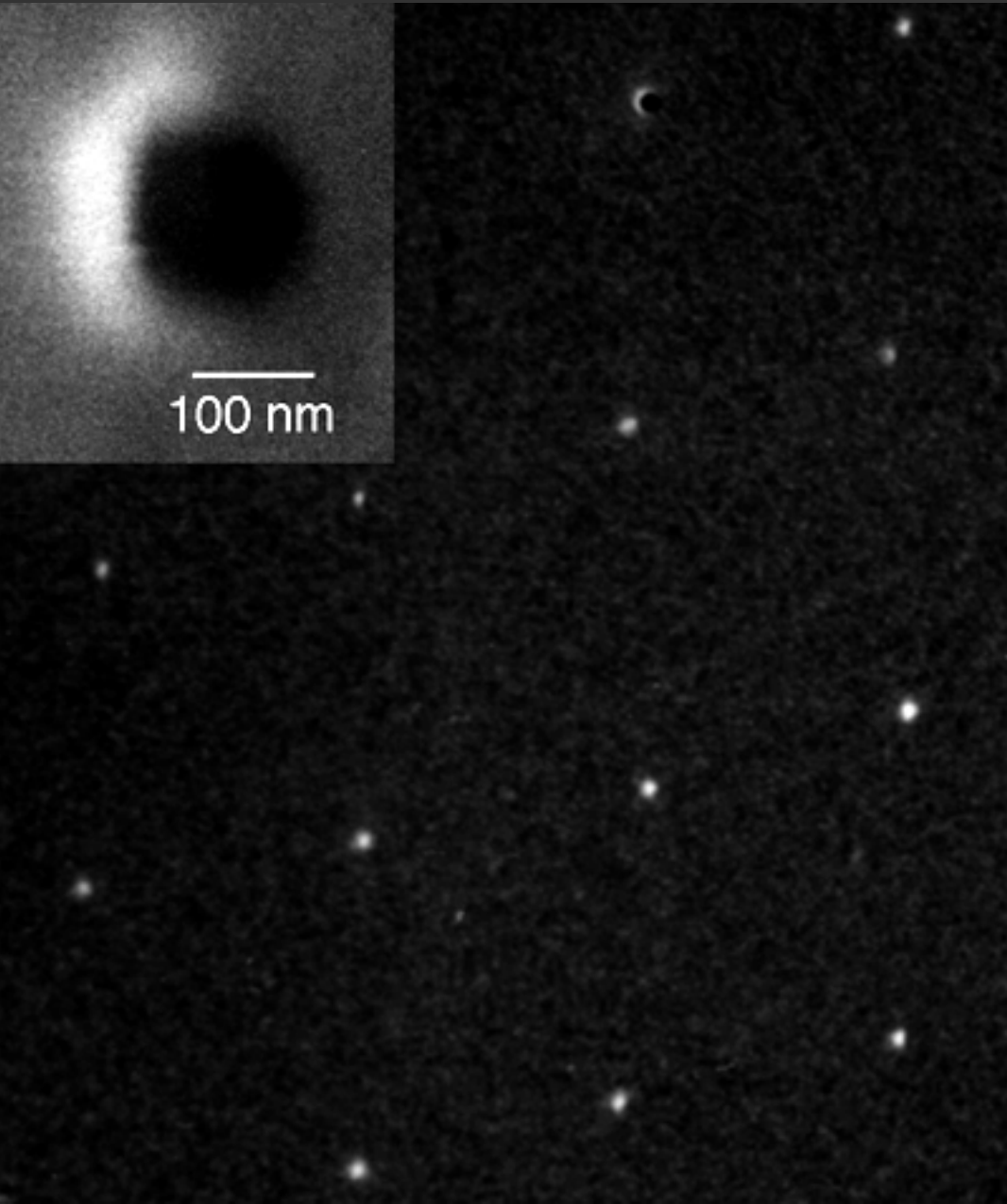
1.4 NA

Corning 0211

# *Damage morphology*



# *Damage morphology*



**Electron Microscopy:**

**explosive damage  
forms voids**

**100 fs, 500 nJ  
0.65 NA  
fused silica**

# *Damage morphology*

## summary of damage mechanisms

---

**single shot**

**multiple shot  
(25 MHz)**

---

**low energy**

**high energy**

---



# *Damage morphology*

## summary of damage mechanisms

---

|                    | <b>single shot</b> | <b>multiple shot<br/>(25 MHz)</b> |
|--------------------|--------------------|-----------------------------------|
| <b>low energy</b>  |                    |                                   |
| <b>high energy</b> | <b>explosive</b>   |                                   |

---

# *Damage morphology*

## summary of damage mechanisms

---

|                    | <b>single shot</b> | <b>multiple shot<br/>(25 MHz)</b> |
|--------------------|--------------------|-----------------------------------|
| <b>low energy</b>  |                    | <b>thermal</b>                    |
| <b>high energy</b> | <b>explosive</b>   |                                   |

---

# *Damage morphology*

## summary of damage mechanisms

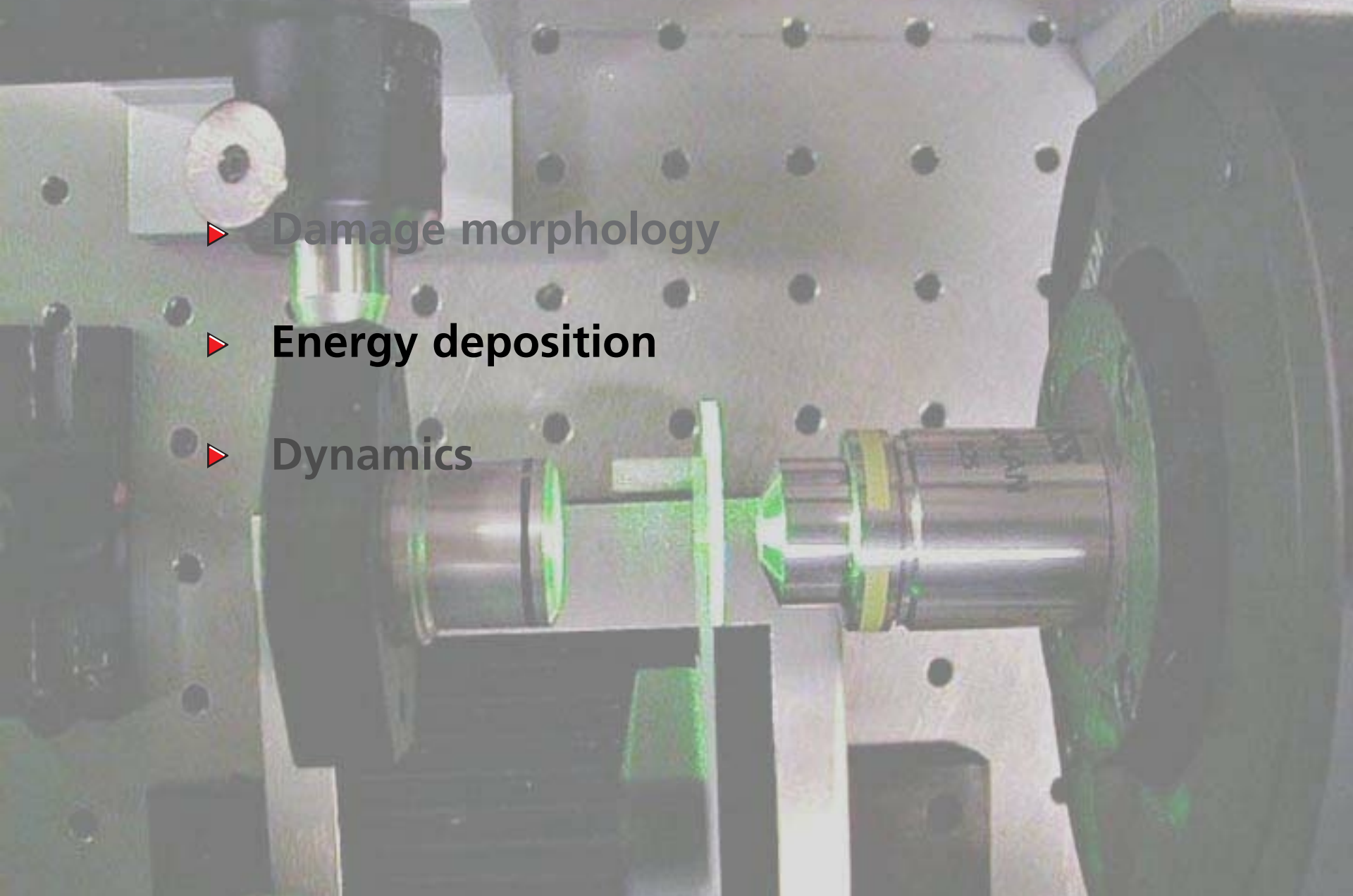
---

|                    | <b>single shot</b> | <b>multiple shot<br/>(25 MHz)</b> |
|--------------------|--------------------|-----------------------------------|
| <b>low energy</b>  | <b>?</b>           | <b>thermal</b>                    |
| <b>high energy</b> | <b>explosive</b>   |                                   |

---

# Outline

- ▶ **Damage morphology**
- ▶ **Energy deposition**
- ▶ **Dynamics**



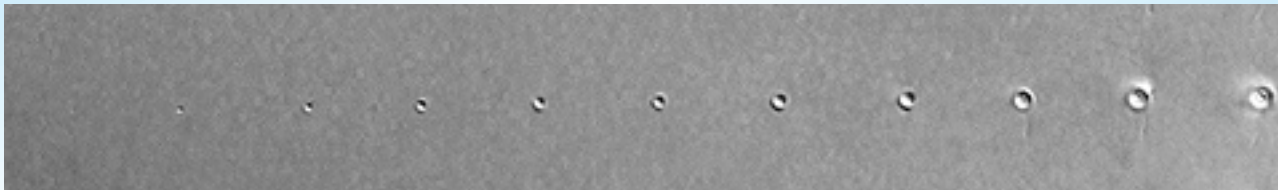
# *Energy deposition*

**Determine threshold for damage:**

- ▶ **Optical microscopy**
- ▶ **Transmission**
- ▶ **Dark field scattering**

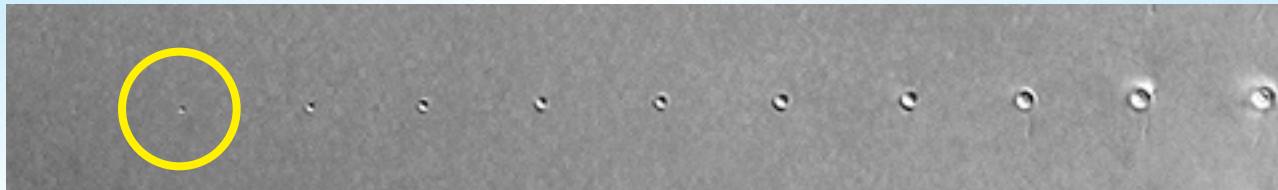
# *Energy deposition*

## **optical microscopy**



# *Energy deposition*

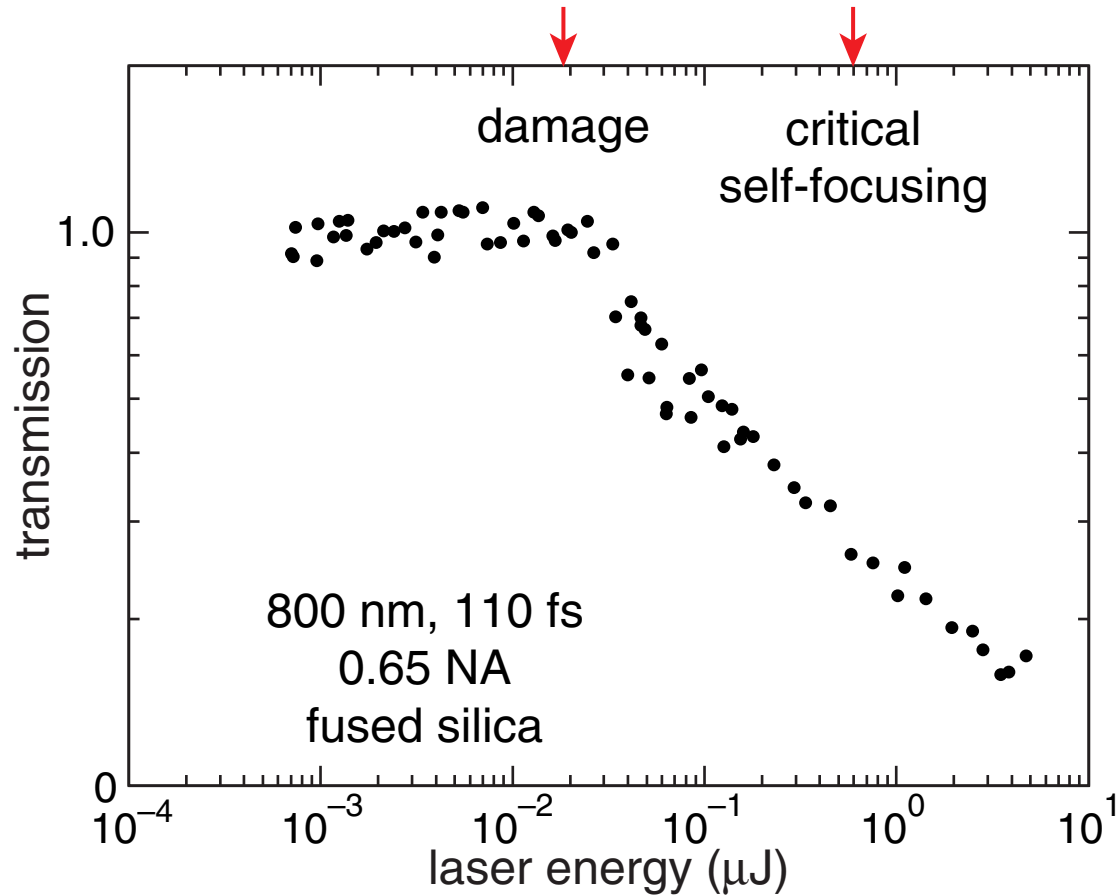
## optical microscopy



**6.6 nJ**

# Energy deposition

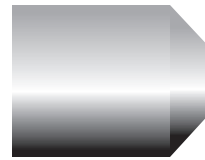
## transmission of pump beam in fused silica





# *Energy deposition*

## **Dark-field scattering**



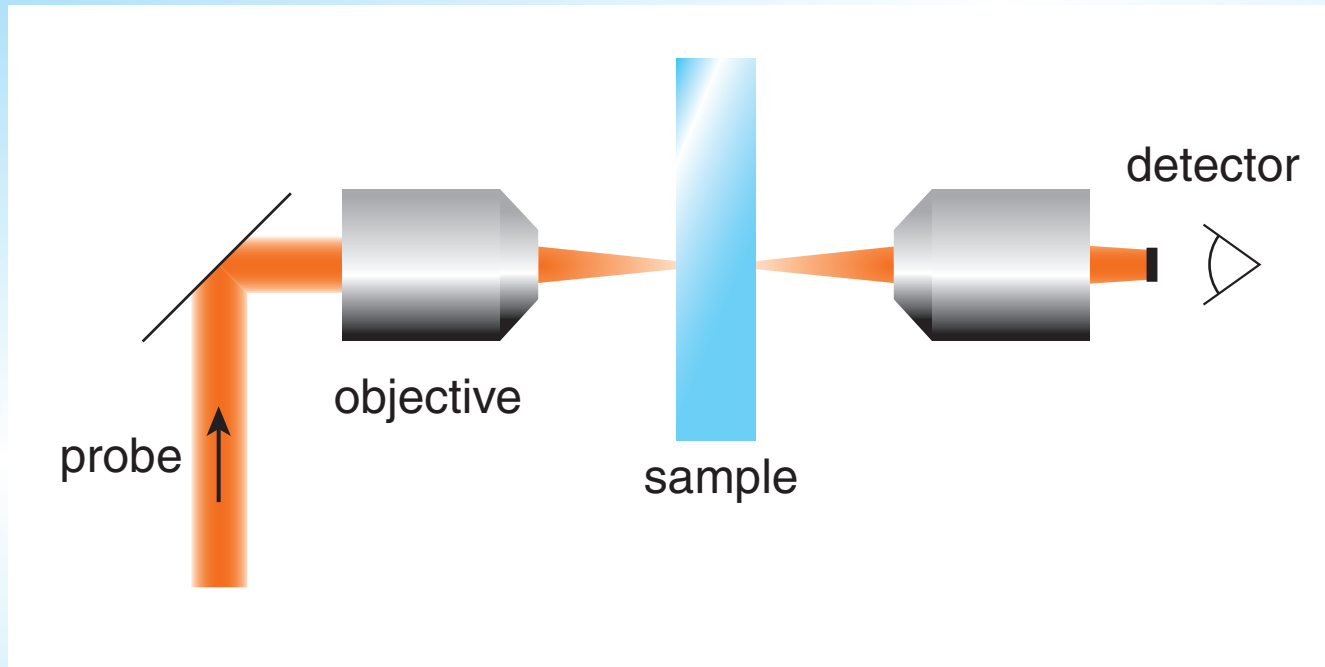
objective



sample

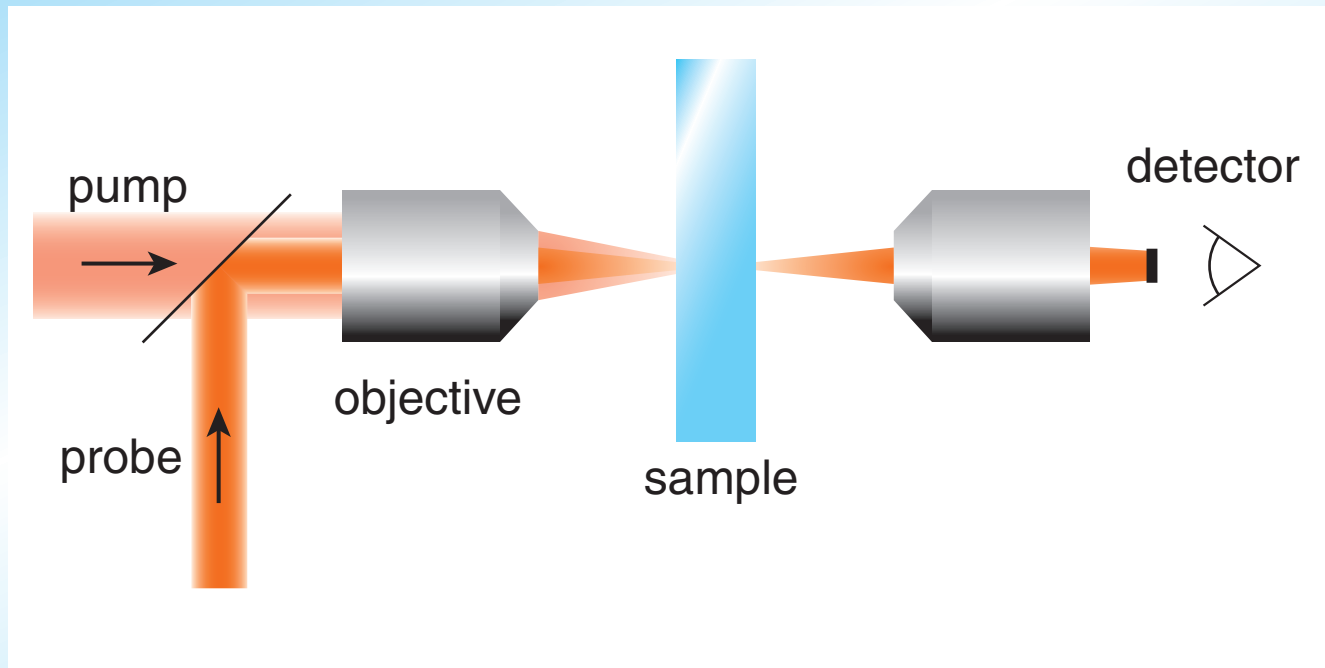
# *Energy deposition*

**block probe beam...**



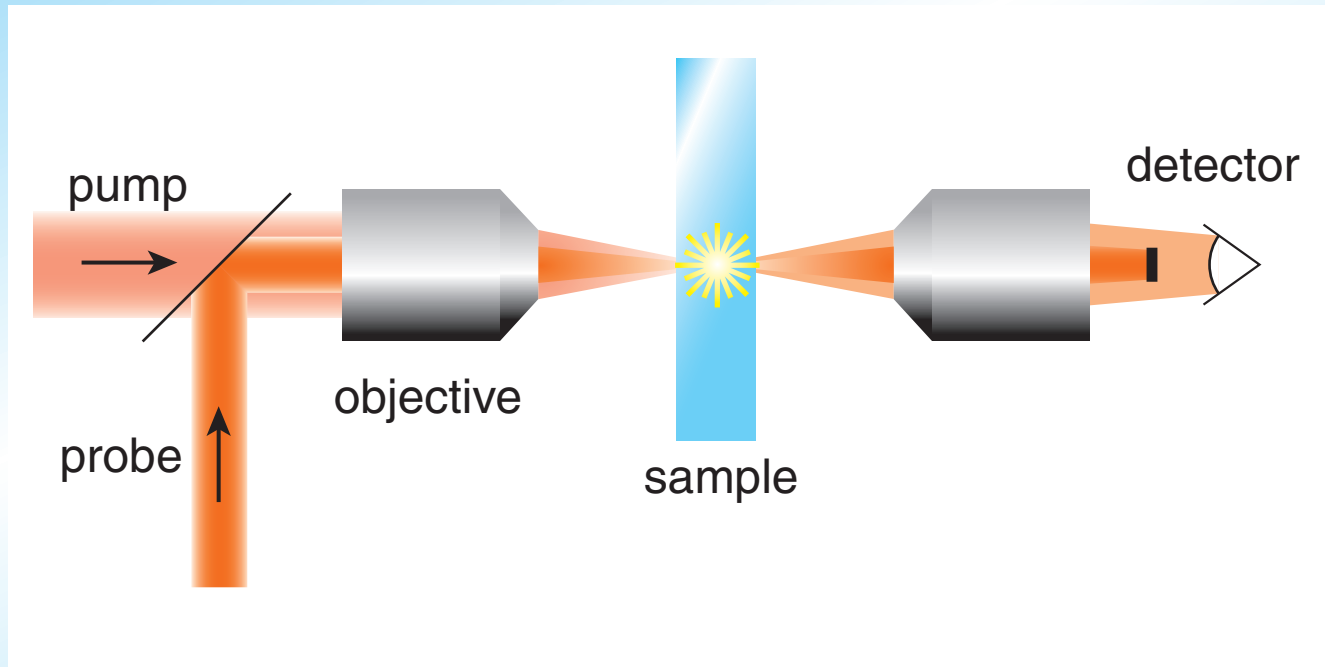
# *Energy deposition*

...bring in pump beam...

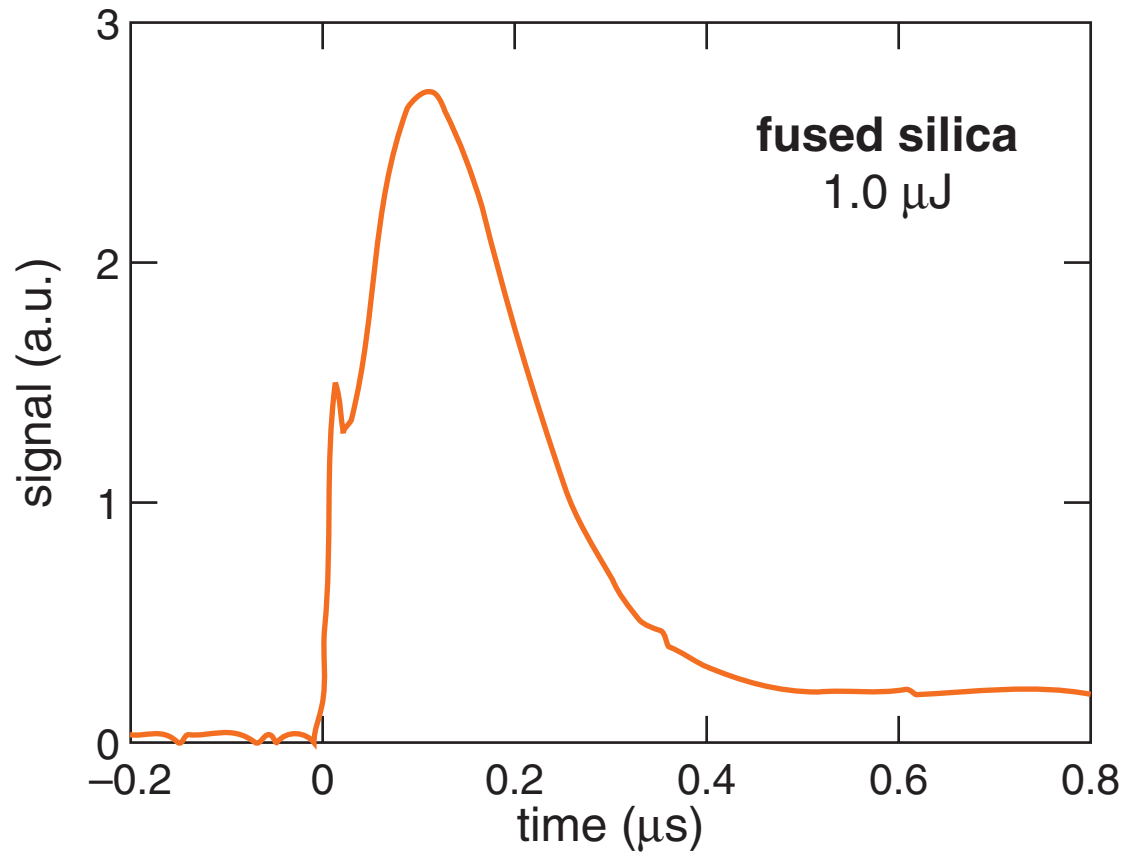


# *Energy deposition*

**...damage scatters probe beam**

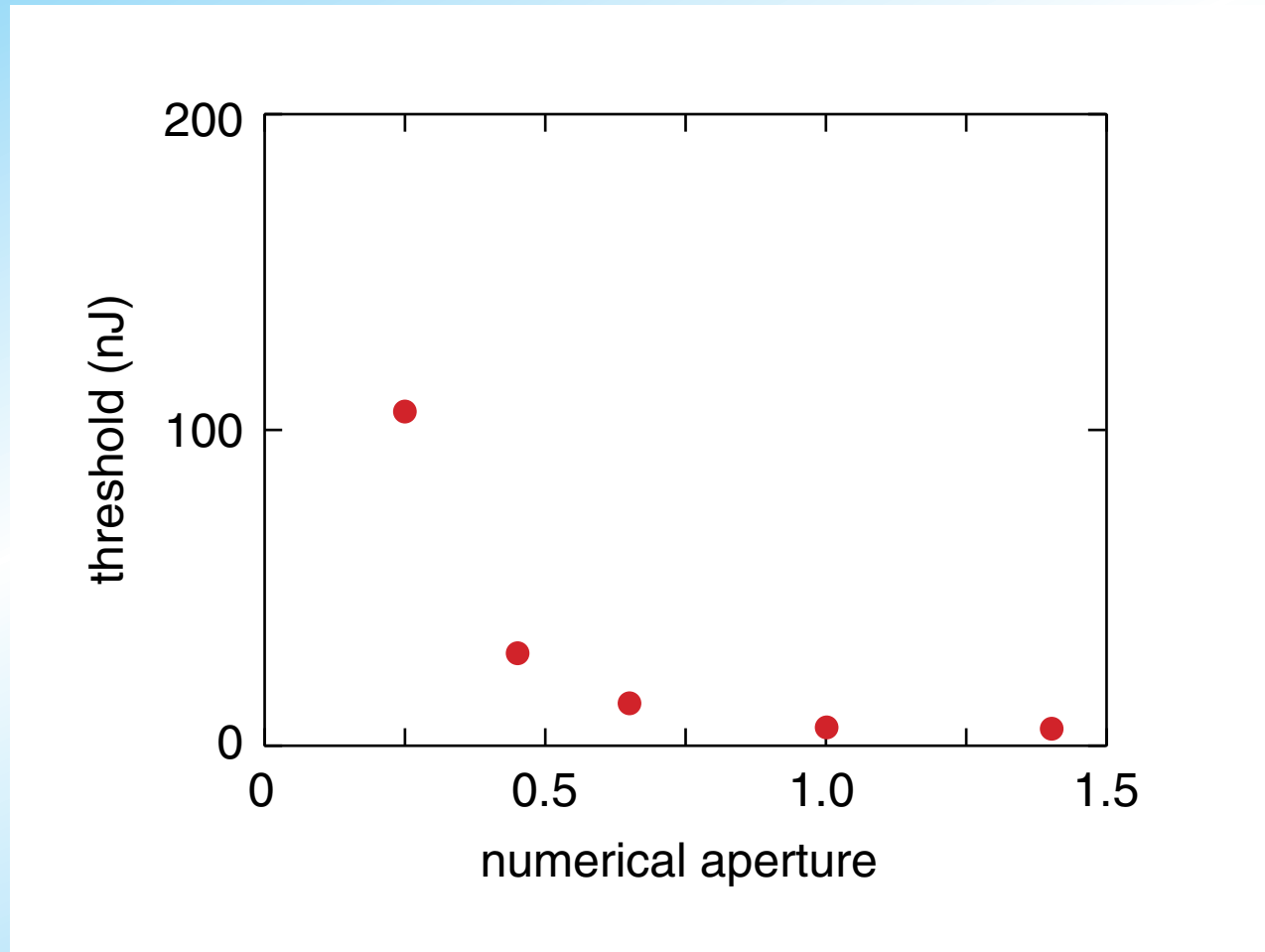


# *Energy deposition*



# *Energy deposition*

**vary numerical aperture in Corning 0211**



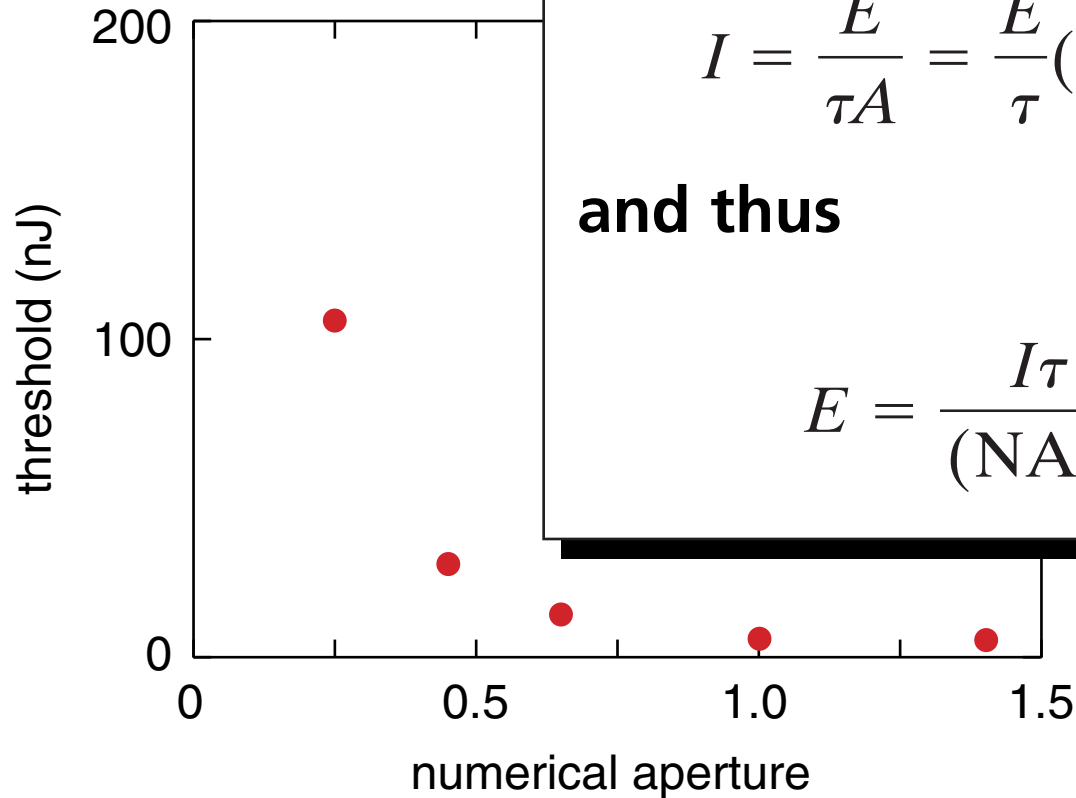
# Energy deposition

minimal self focusing, so  
spot size determined by:

$$I = \frac{E}{\tau A} = \frac{E}{\tau} (\text{NA})^2$$

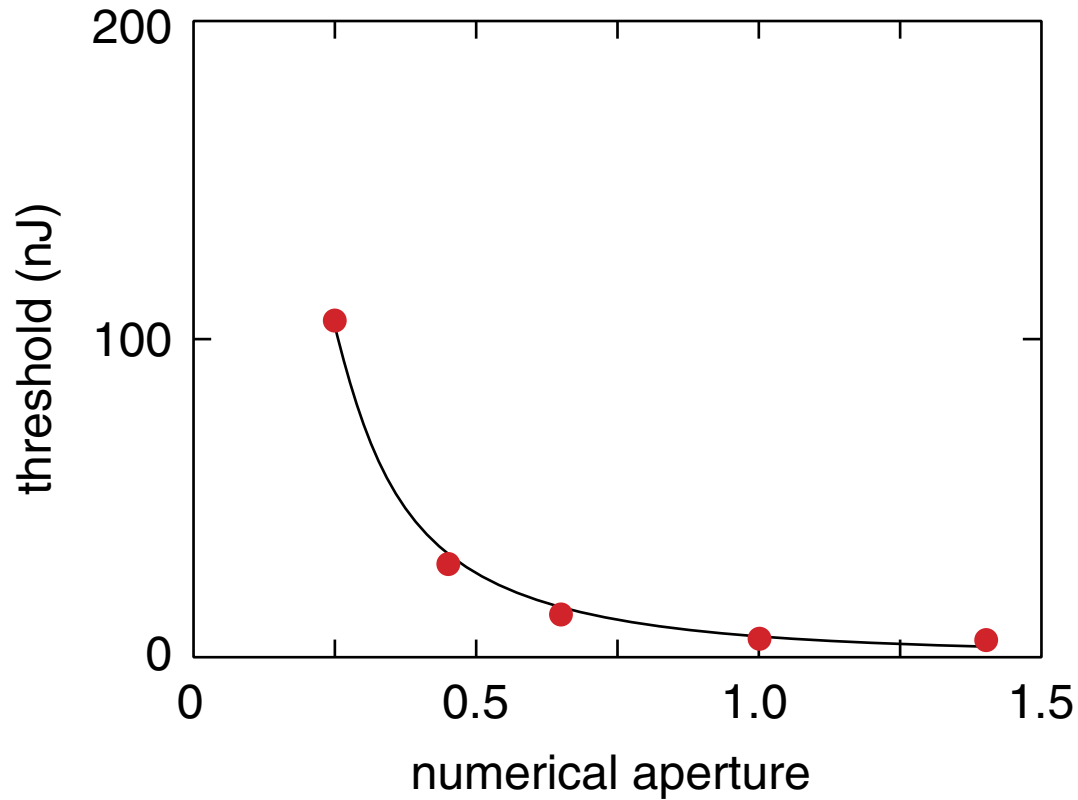
and thus

$$E = \frac{I\tau}{(\text{NA})^2}$$



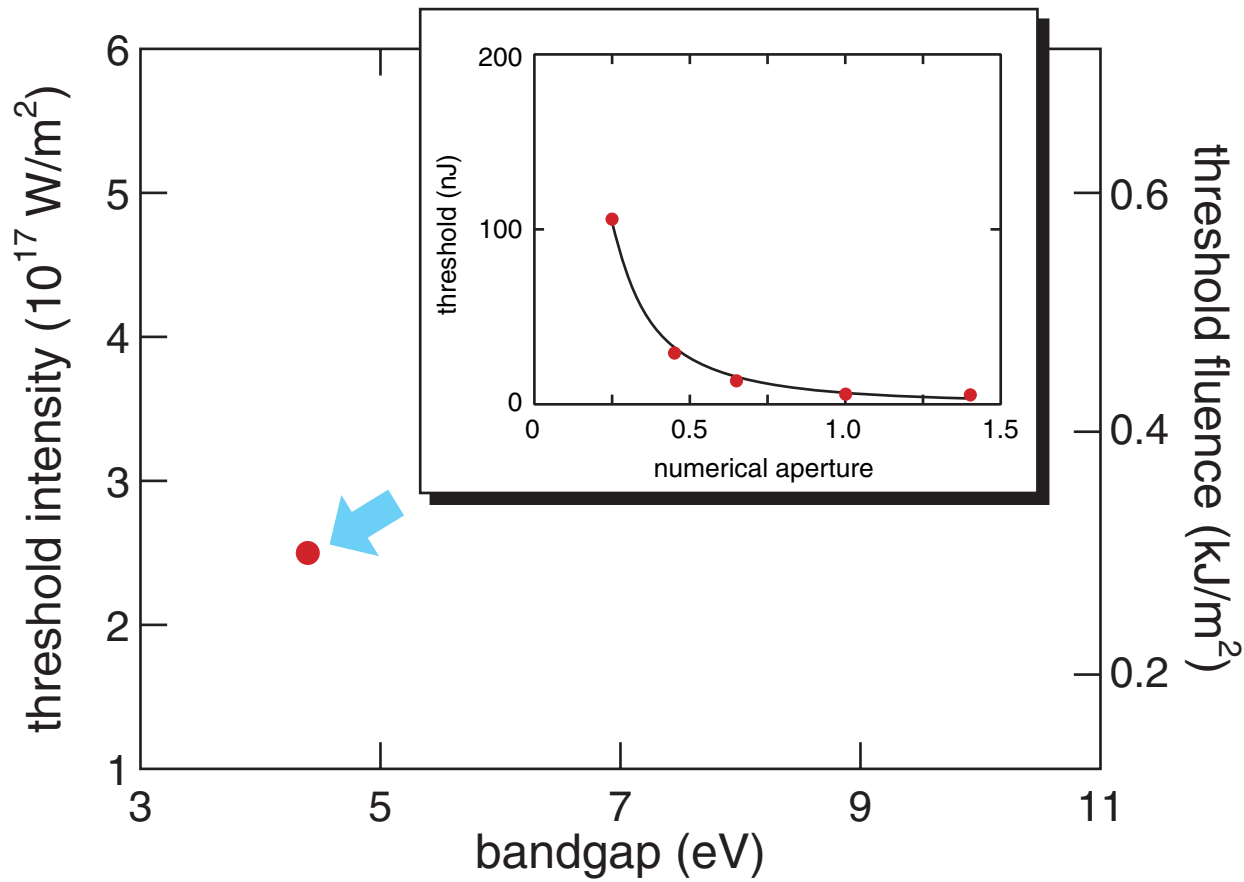
# Energy deposition

fit gives threshold intensity:  $I_{th} = 2.5 \times 10^{17} \text{ W/m}^2$



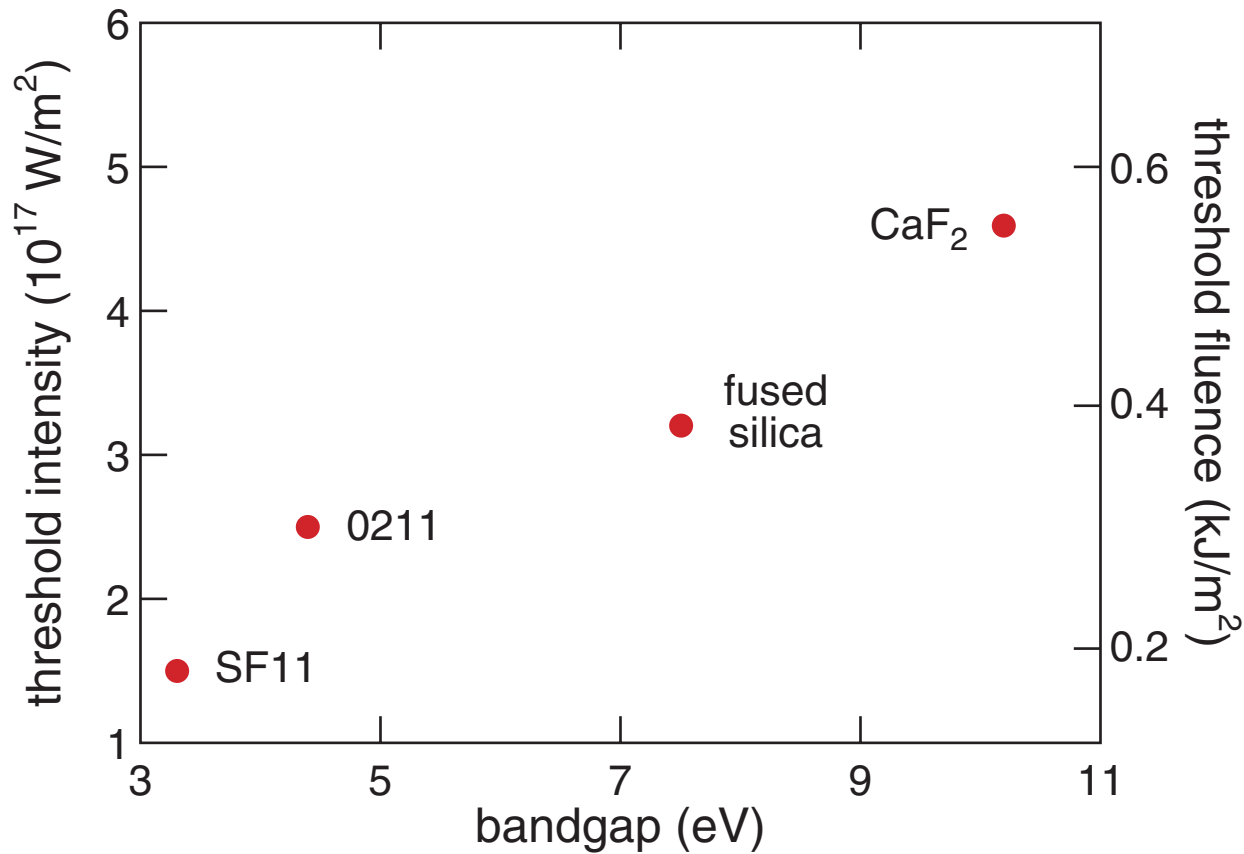


# Energy deposition



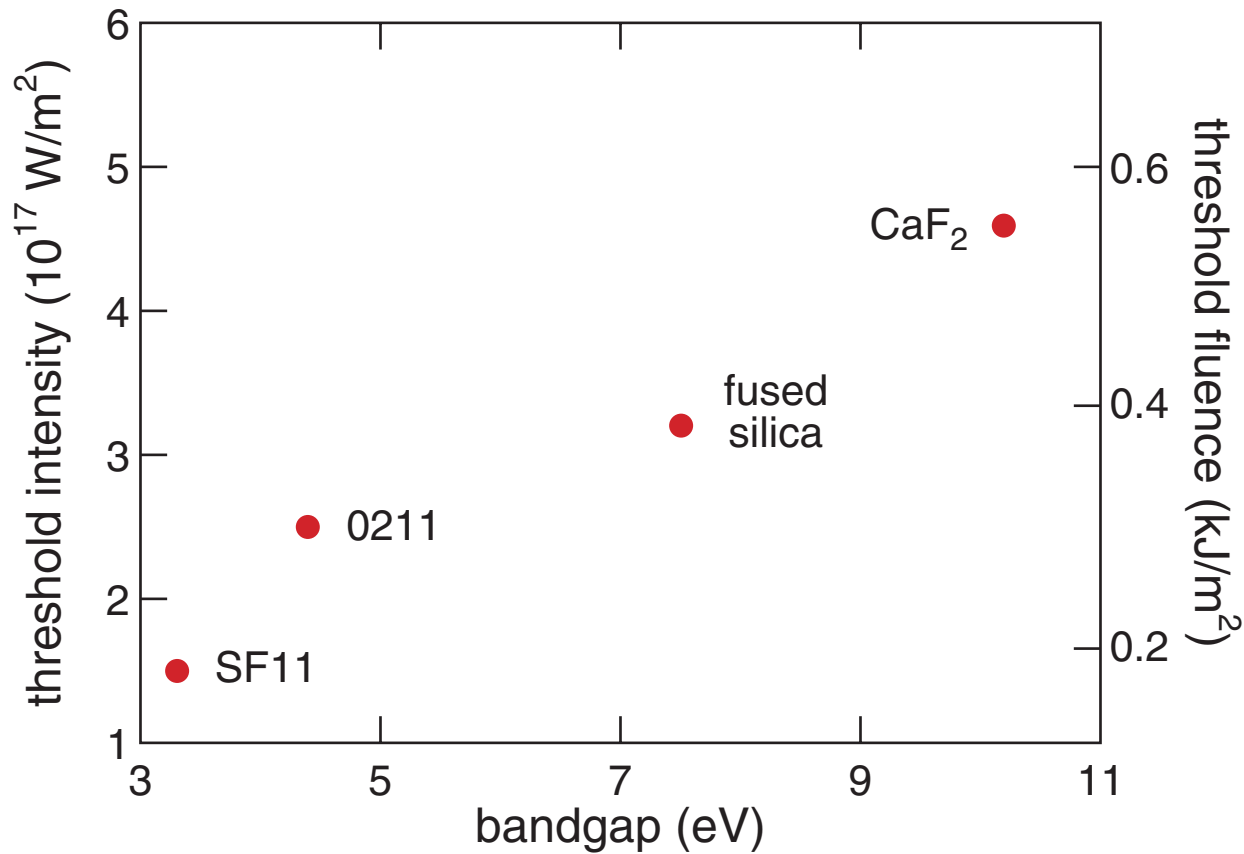
# Energy deposition

vary material...



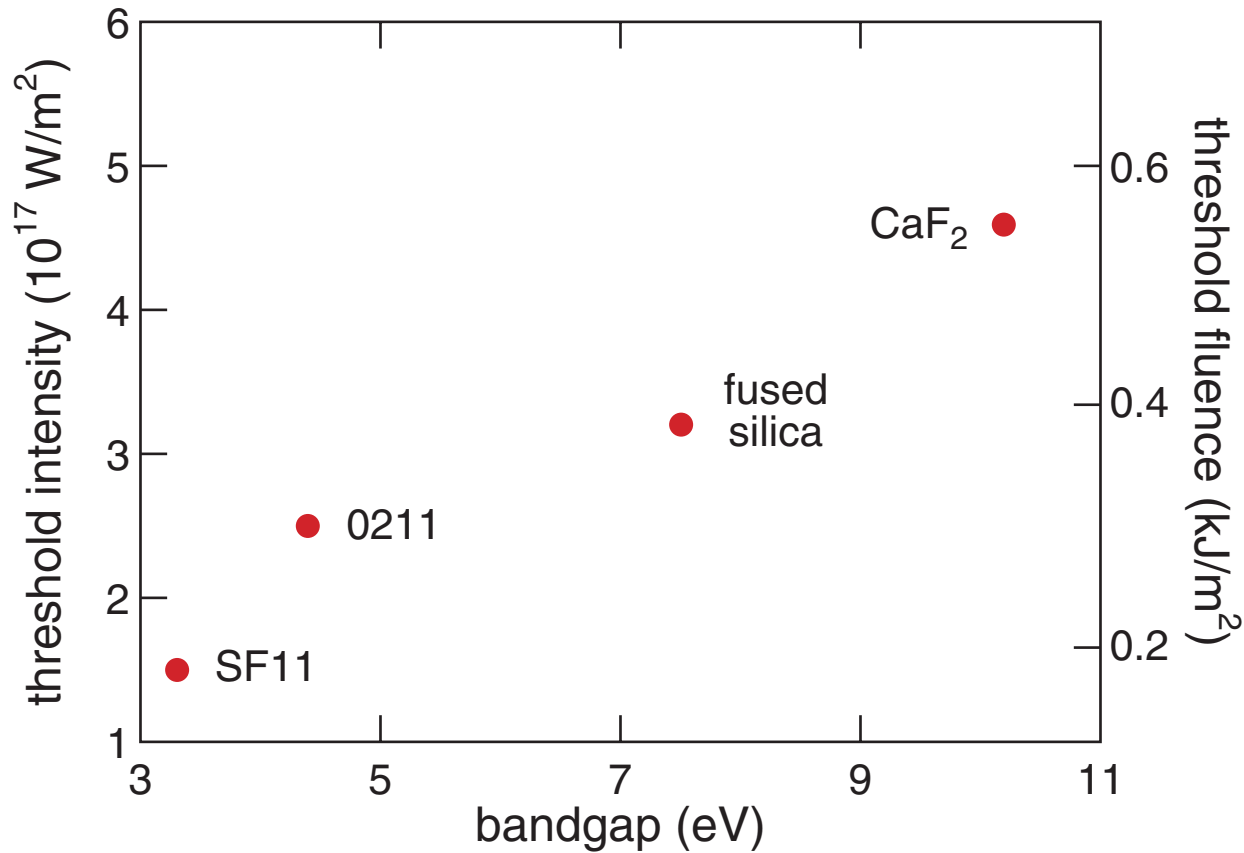
# Energy deposition

threshold increases with bandgap...



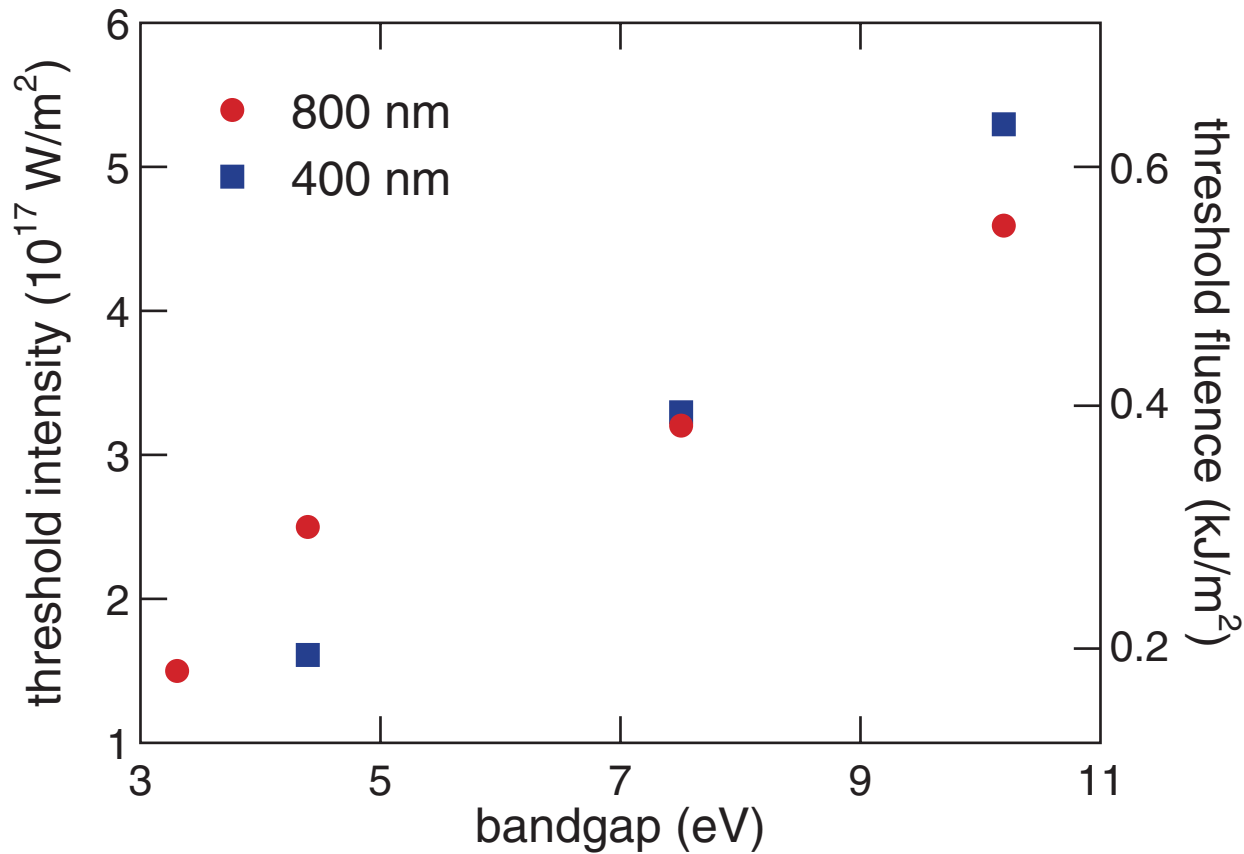
# Energy deposition

...but not very much



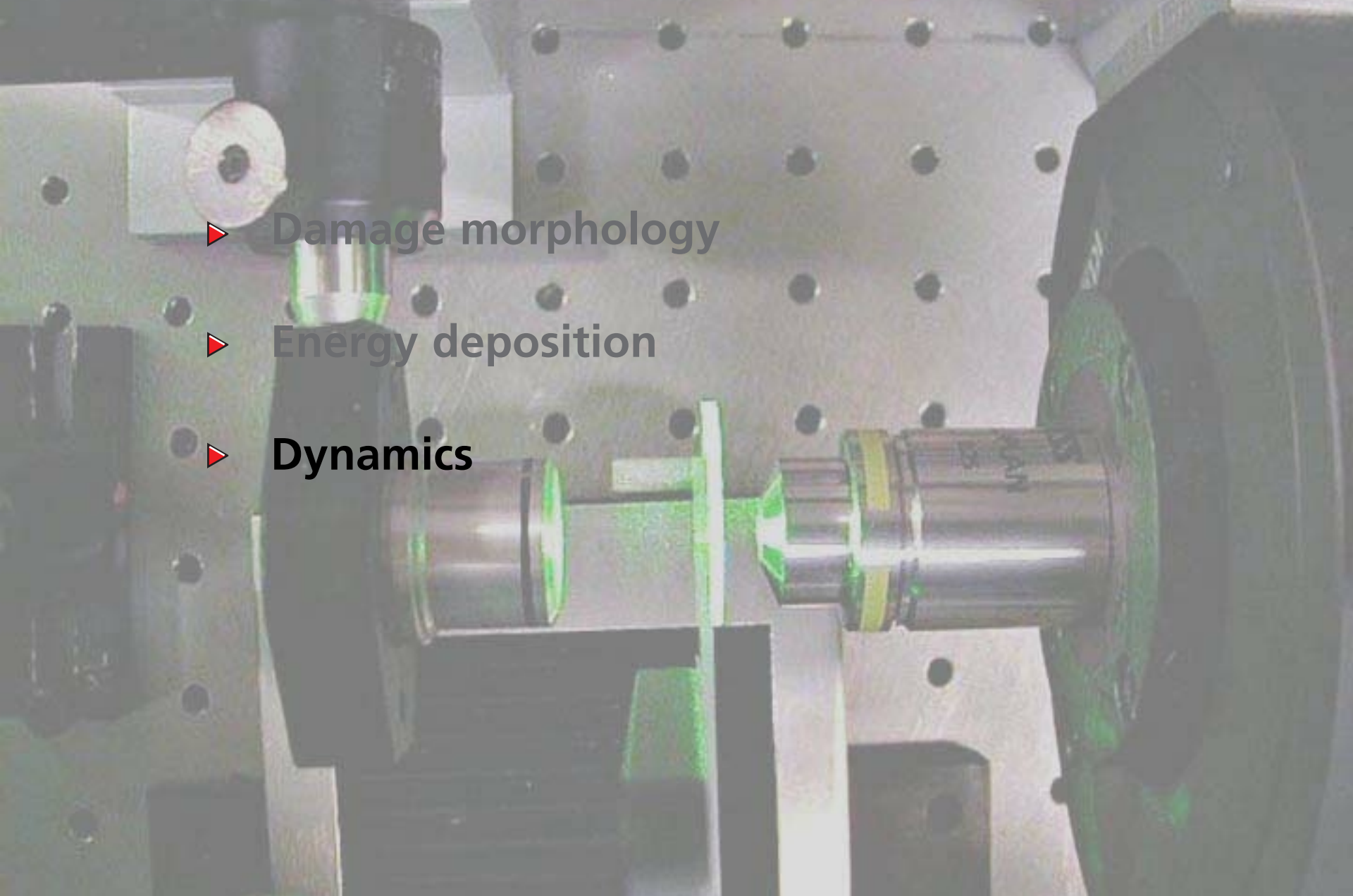
# Energy deposition

same trend at 400 nm



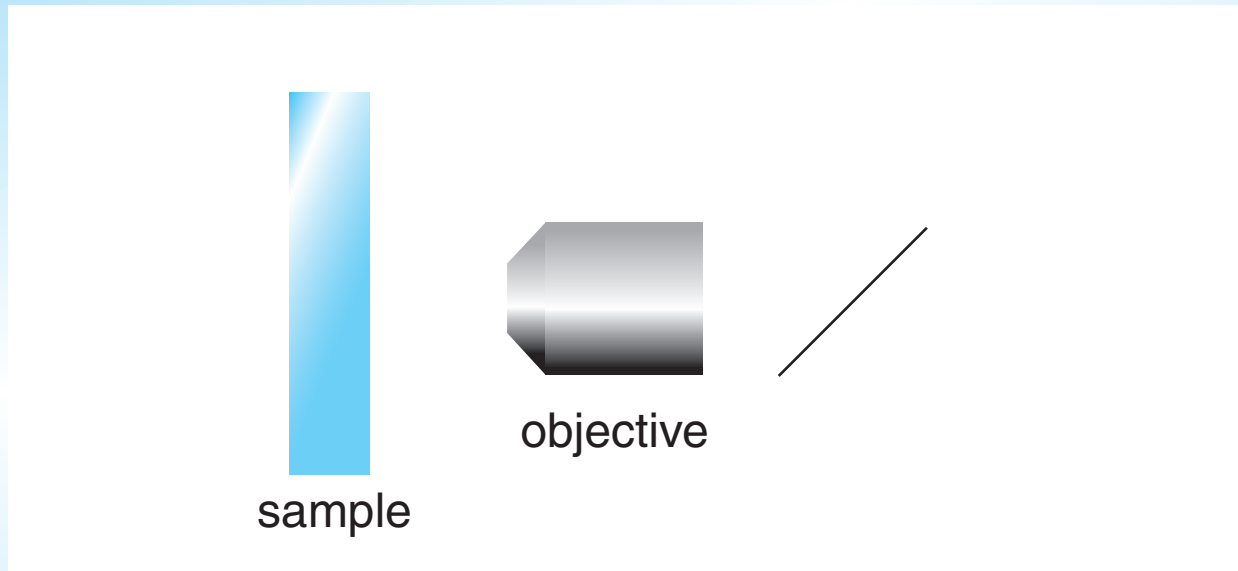
# Outline

- ▶ **Damage morphology**
- ▶ **Energy deposition**
- ▶ **Dynamics**



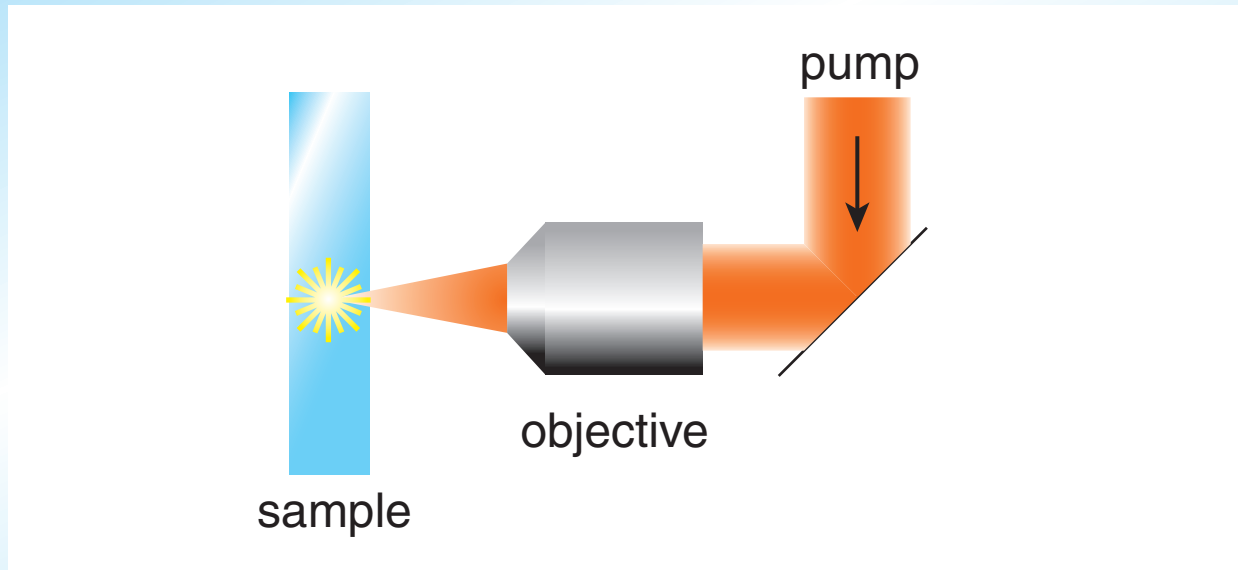
# *Dynamics*

## imaging setup



# *Dynamics*

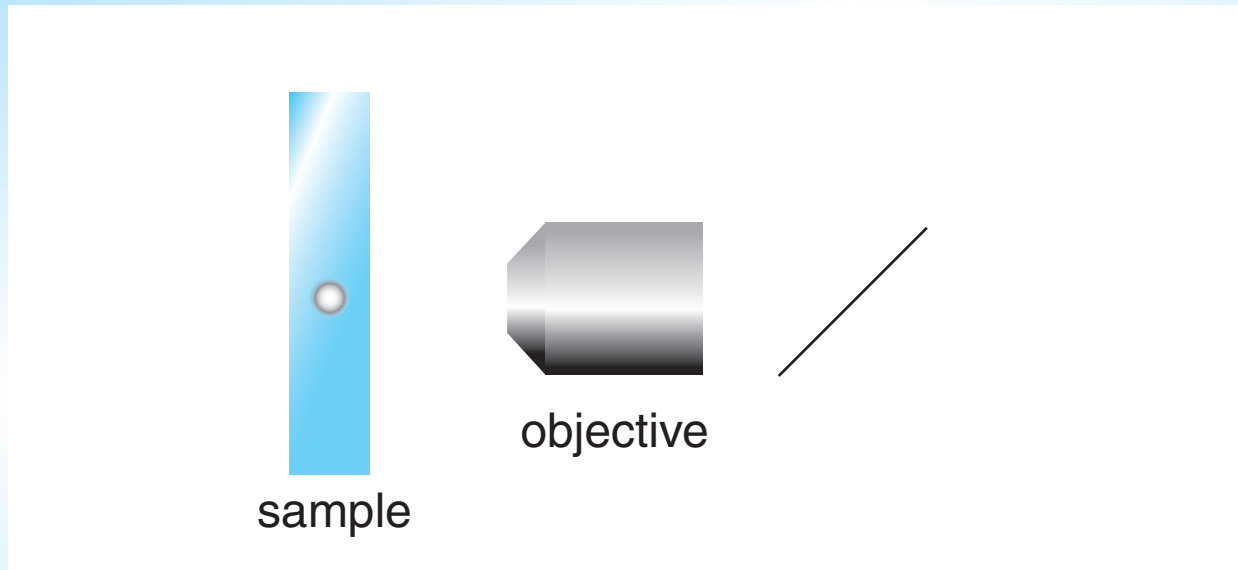
## imaging setup





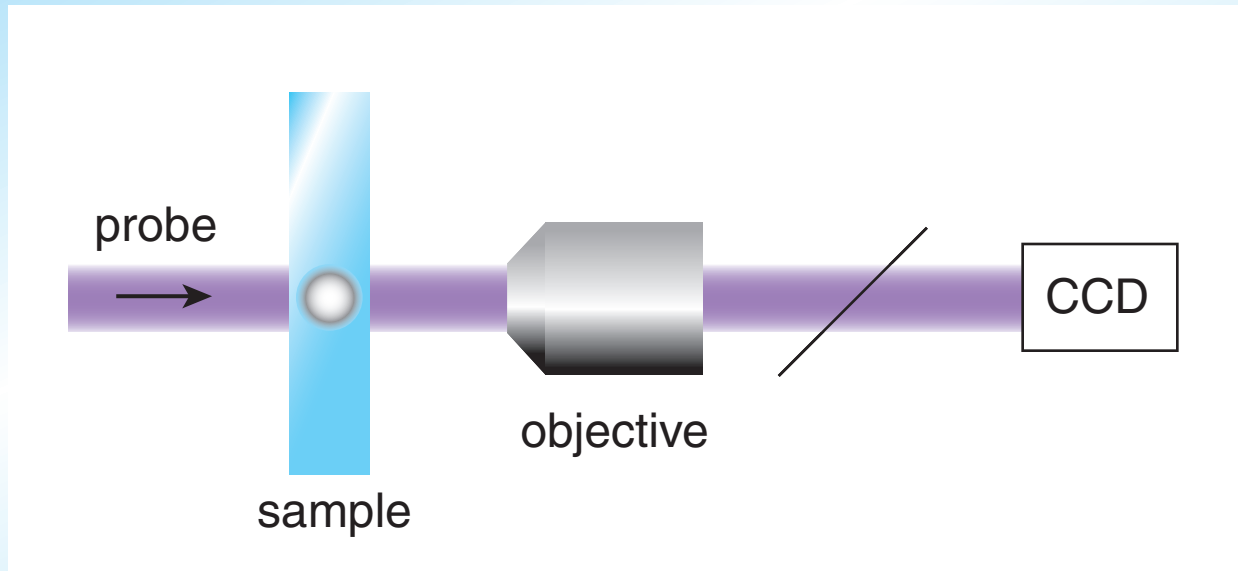
# *Dynamics*

## imaging setup



# *Dynamics*

## imaging setup



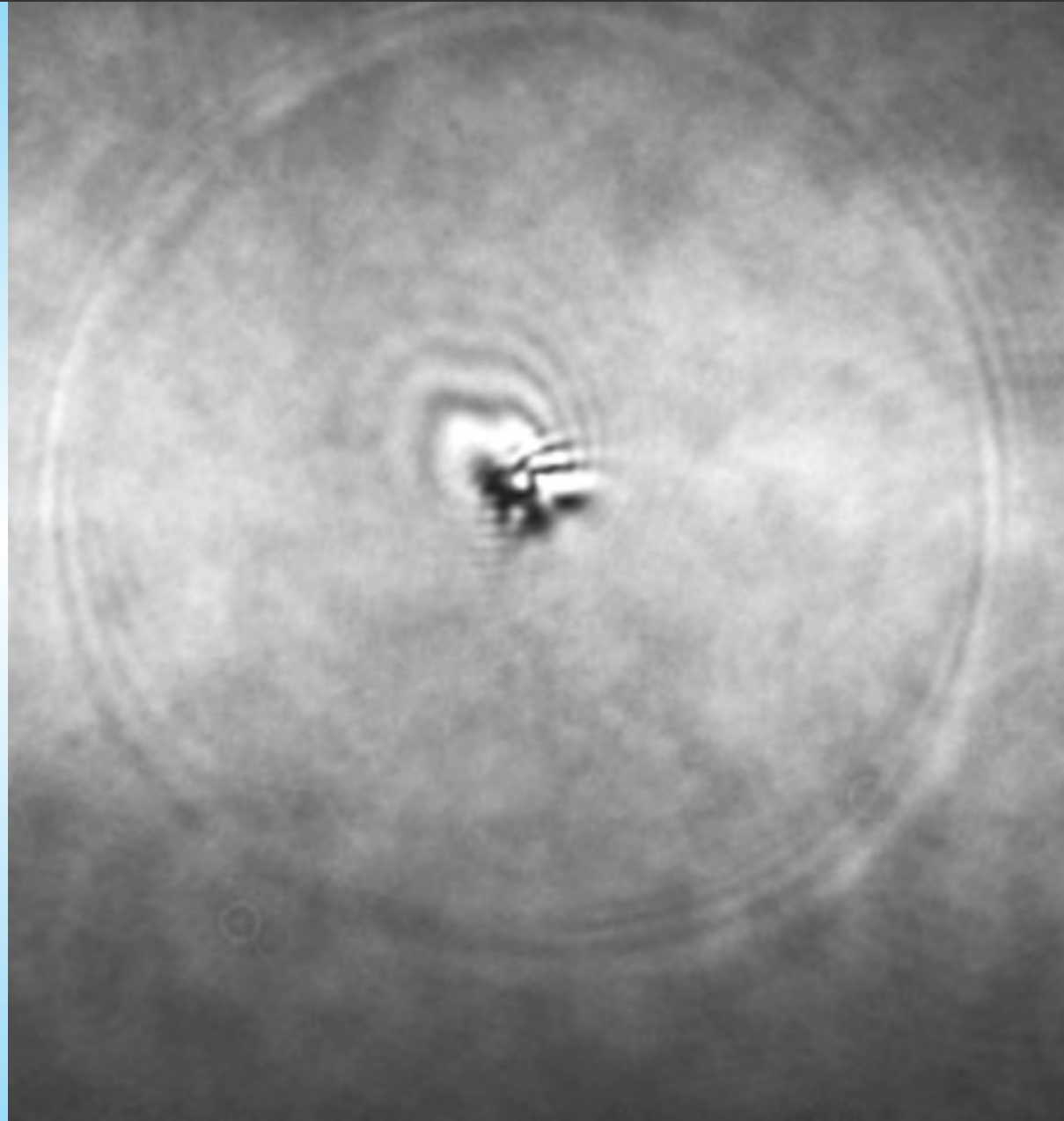
# *Dynamics*

**sapphire**

**3  $\mu\text{J}$  pulse**

**3.8 ns delay**

**40  $\mu\text{m}$  radius**



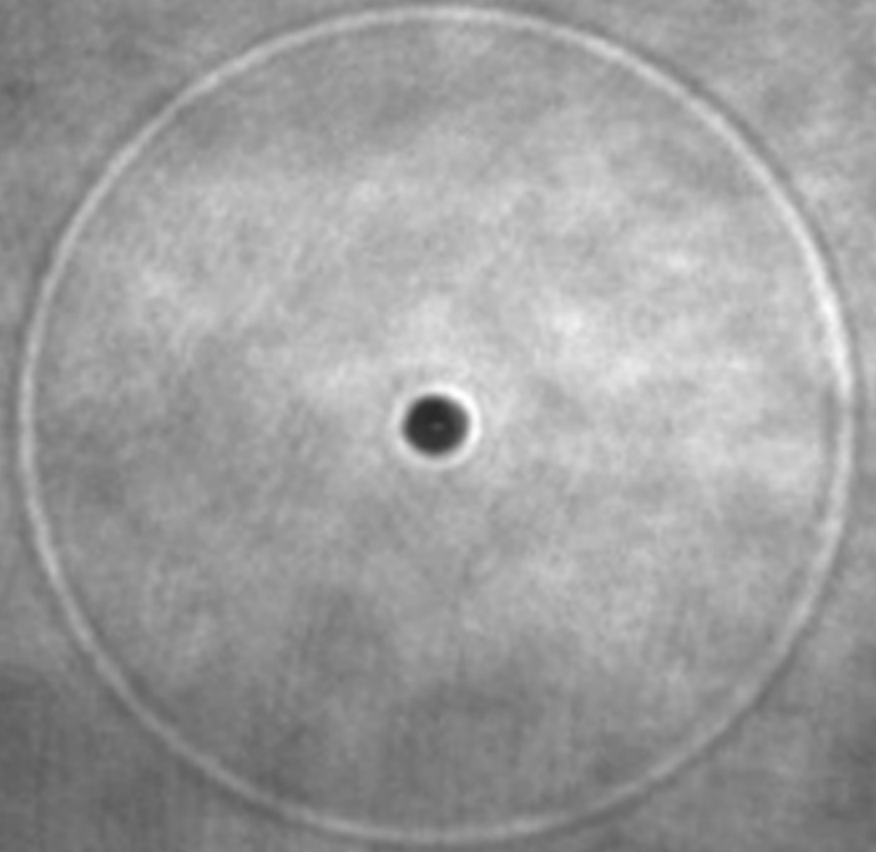
## *Dynamics*

**water (“self-healing”)**

**1.0  $\mu\text{J}$  pulse**

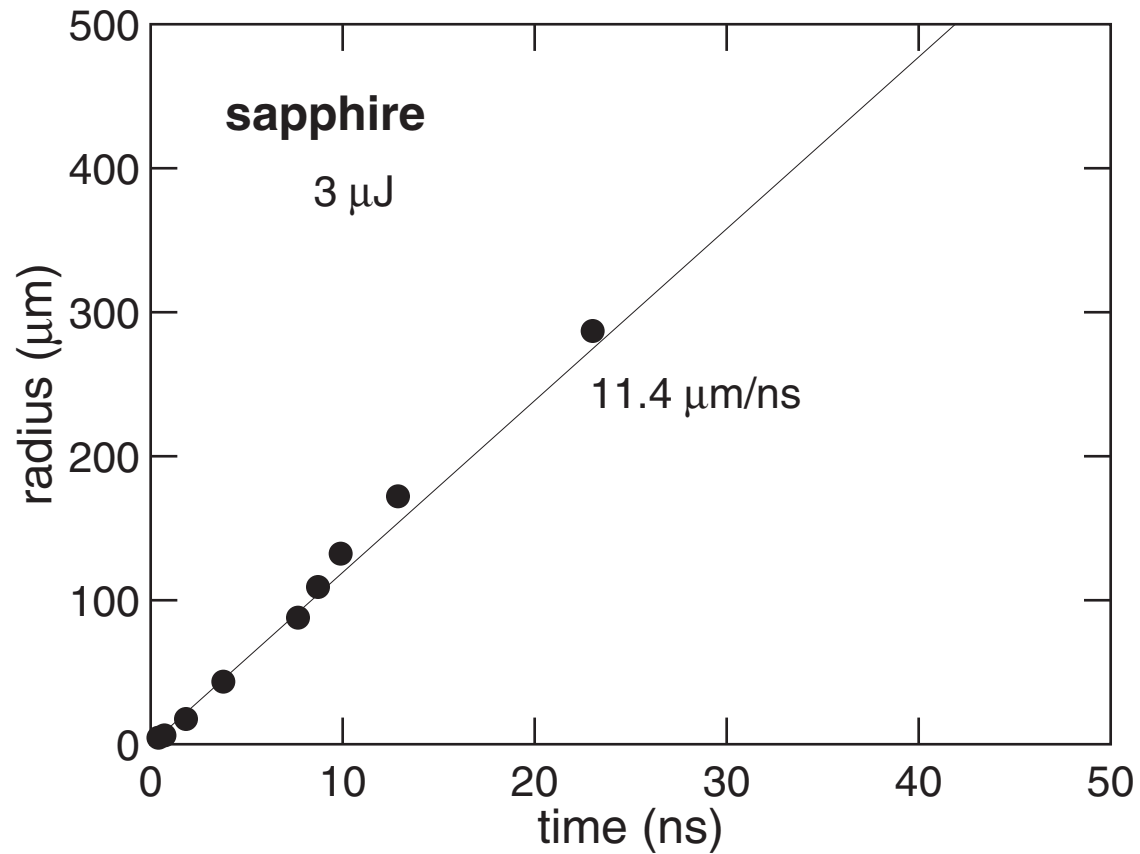
**35 ns delay**

**58  $\mu\text{m}$  radius**

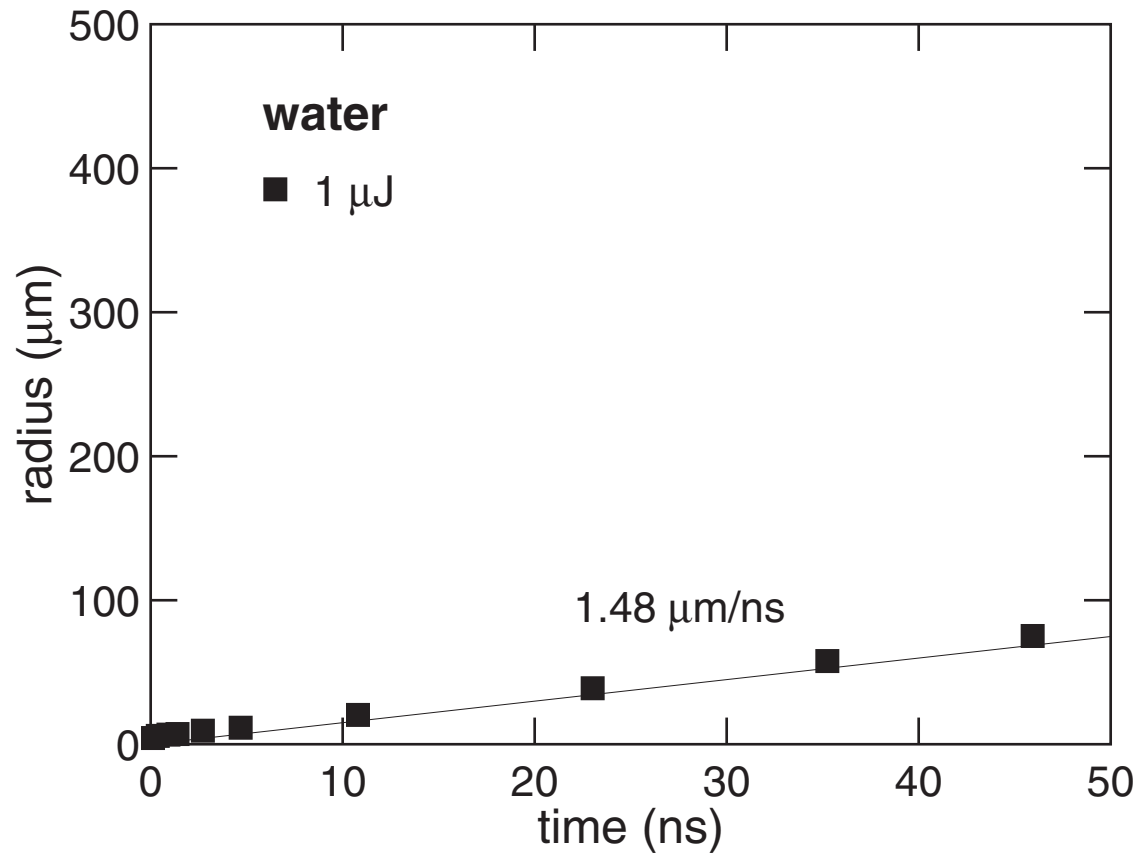


# *Dynamics*

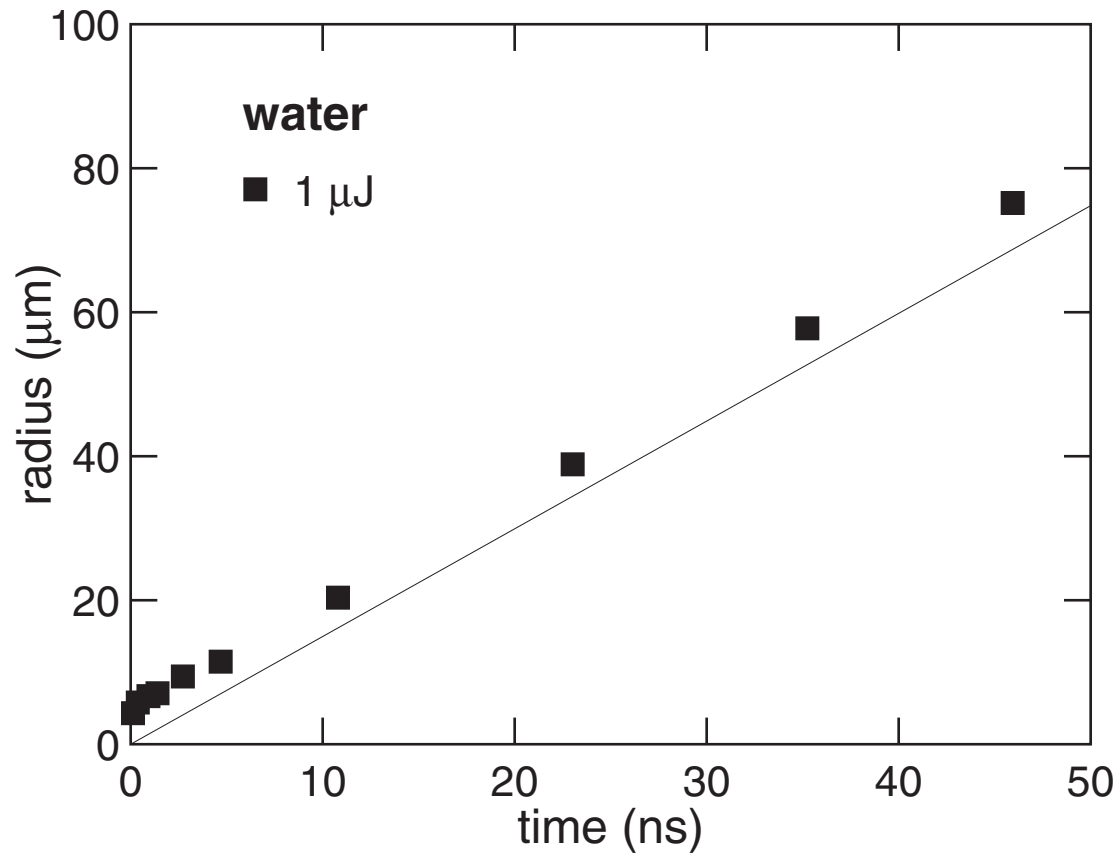
# Dynamics



# Dynamics

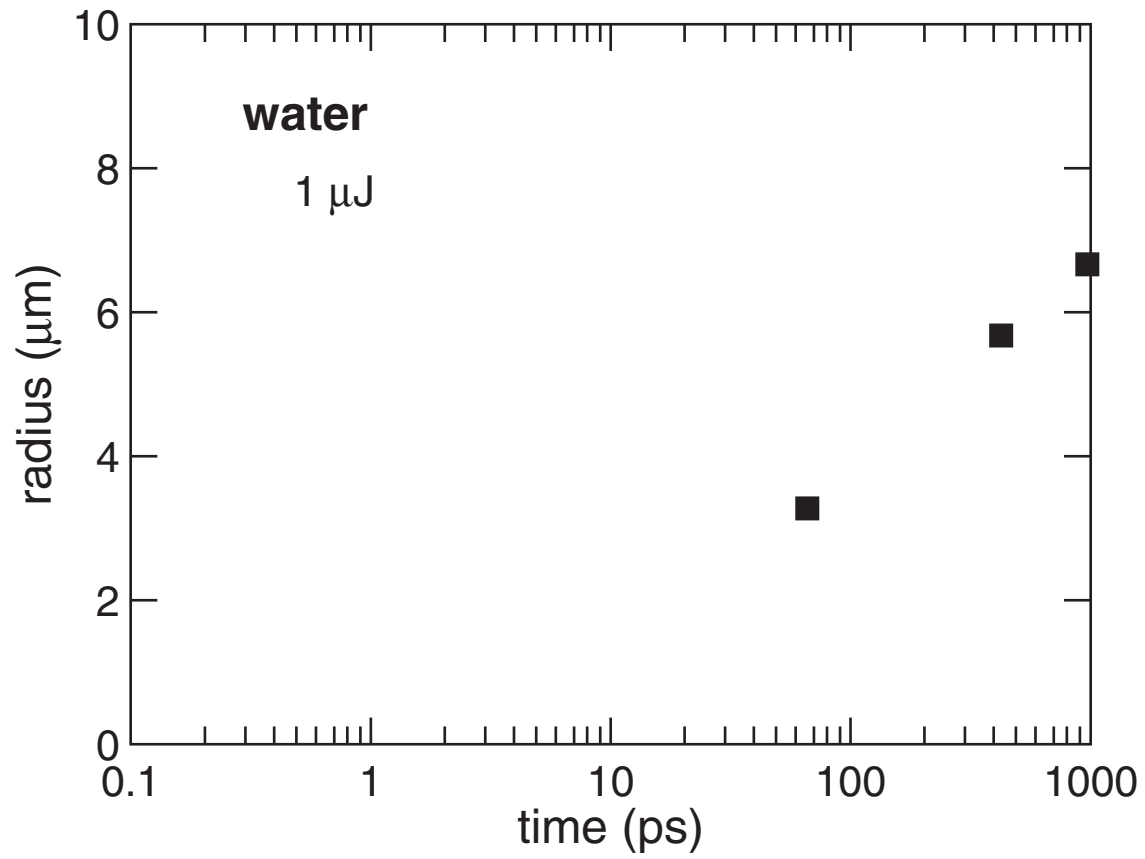


# Dynamics



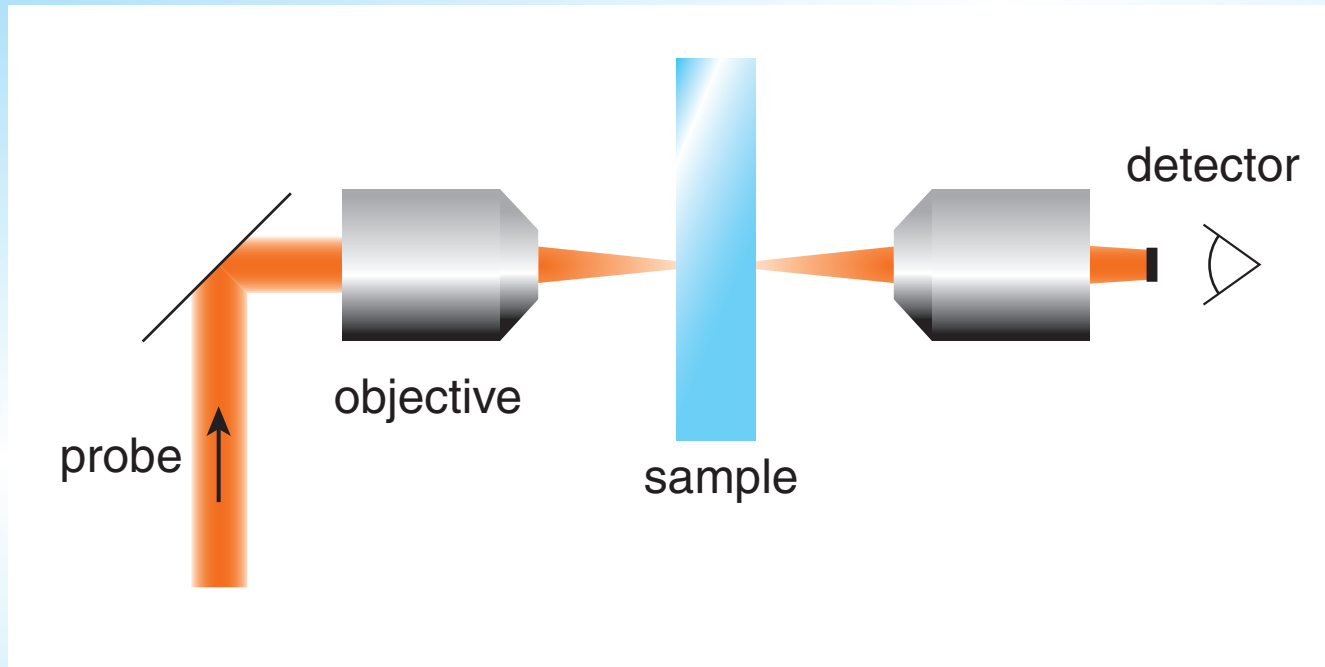


# Dynamics



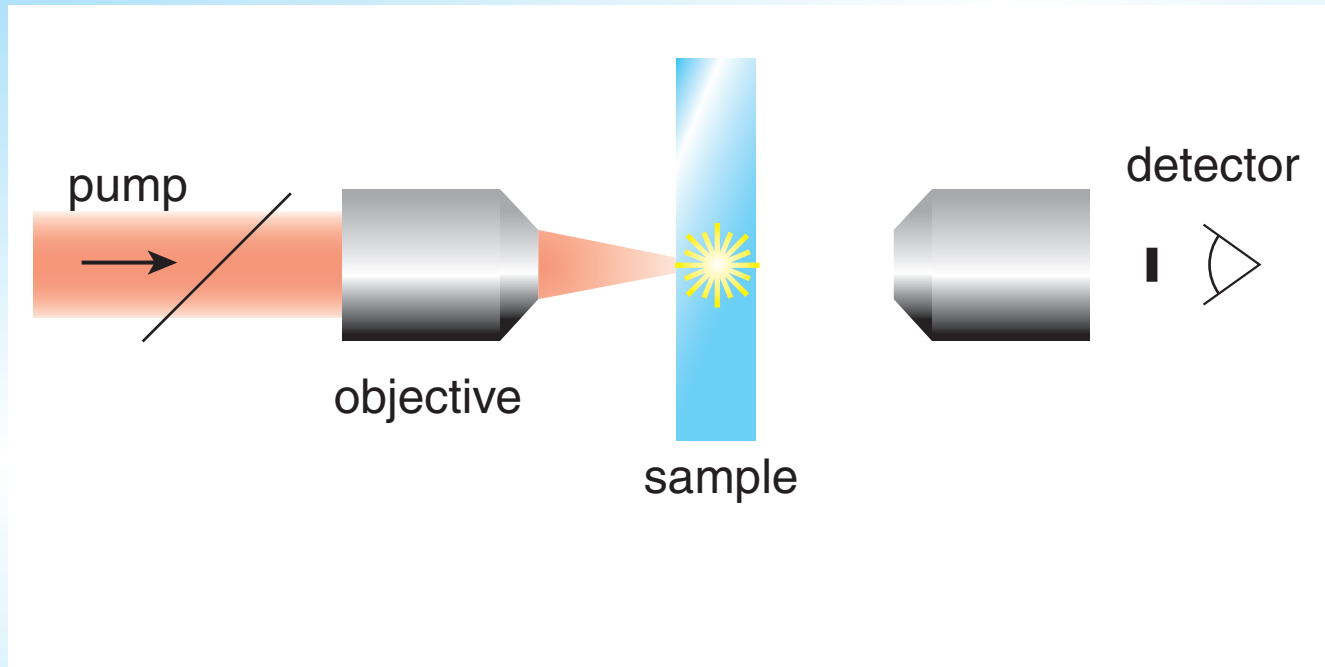
# *Dynamics*

## time-resolved scattering setup



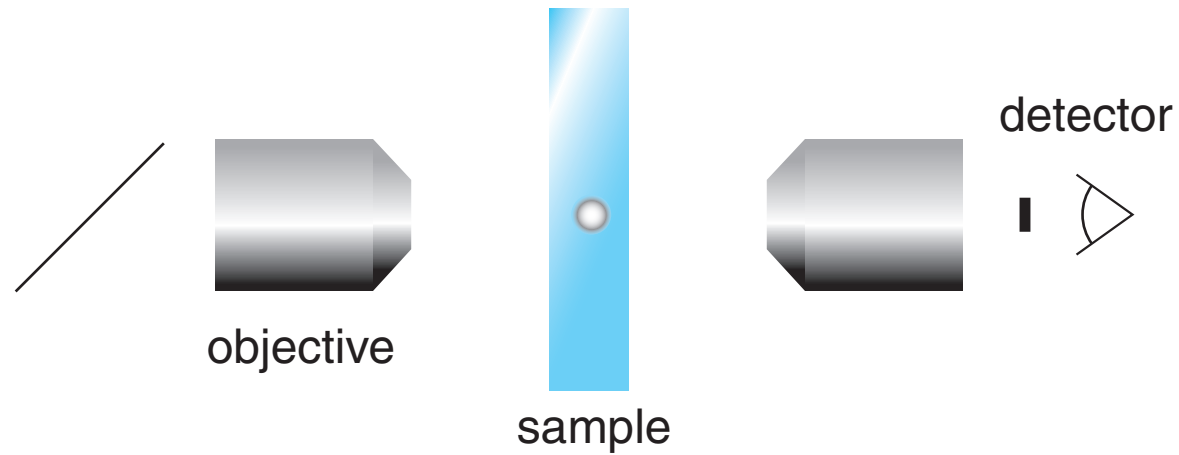
# Dynamics

## time-resolved scattering setup



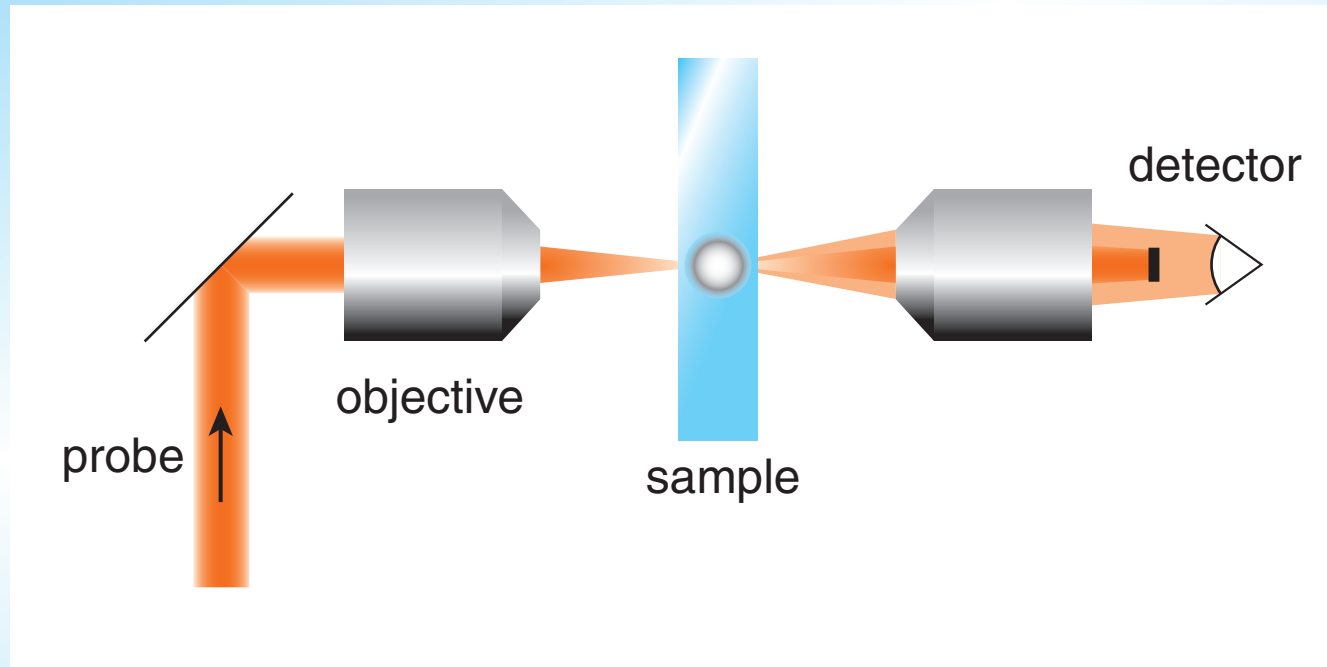
# *Dynamics*

## time-resolved scattering setup



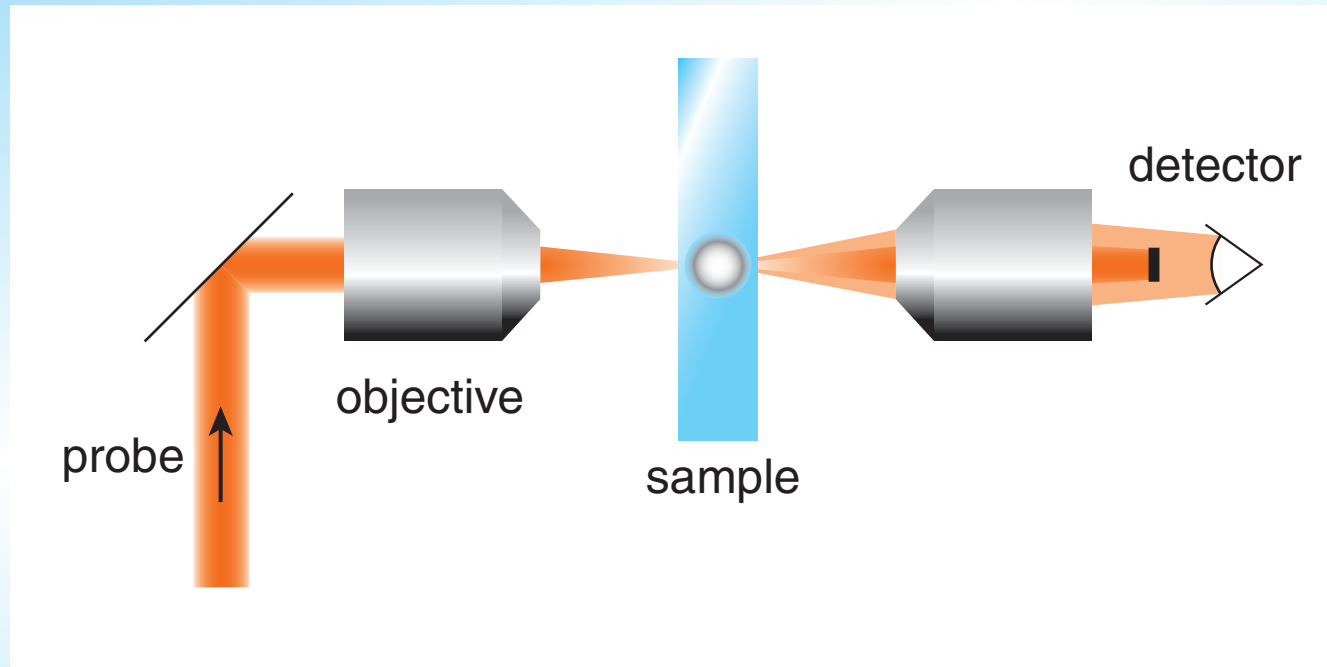
# *Dynamics*

## time-resolved scattering setup



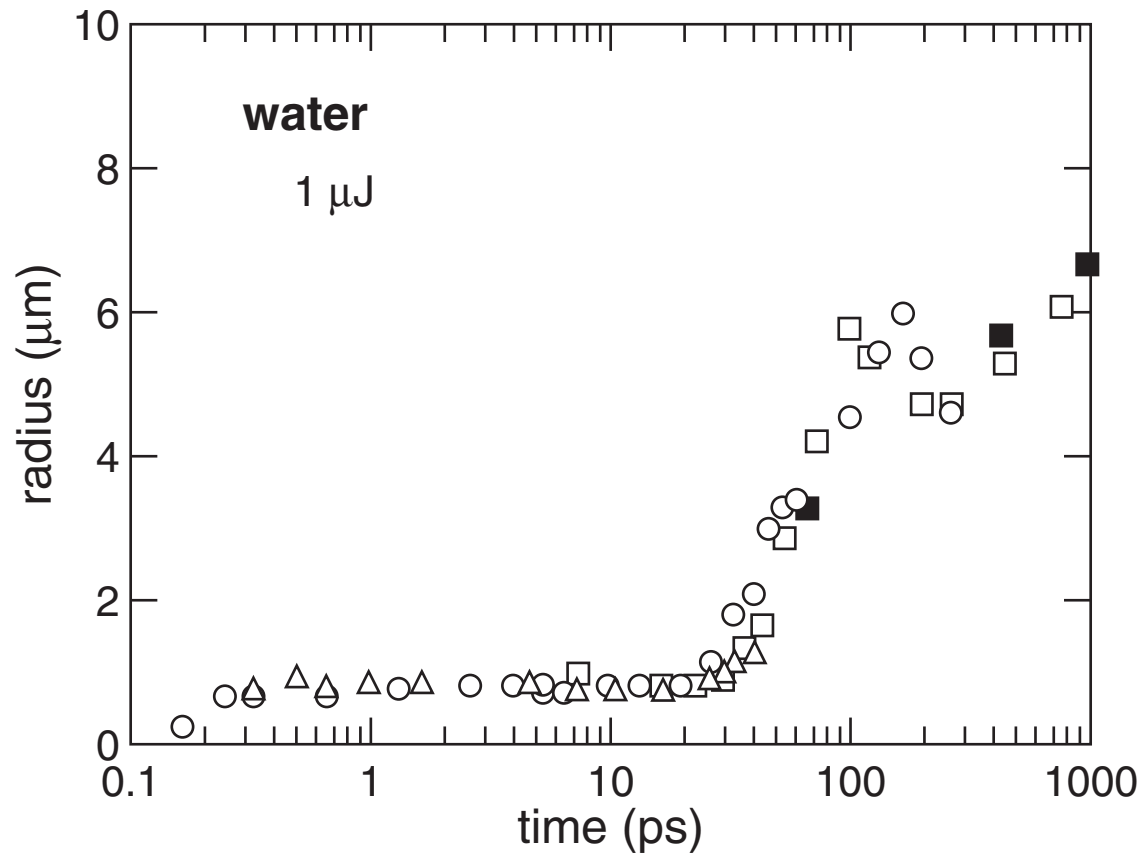
# *Dynamics*

## time-resolved scattering setup

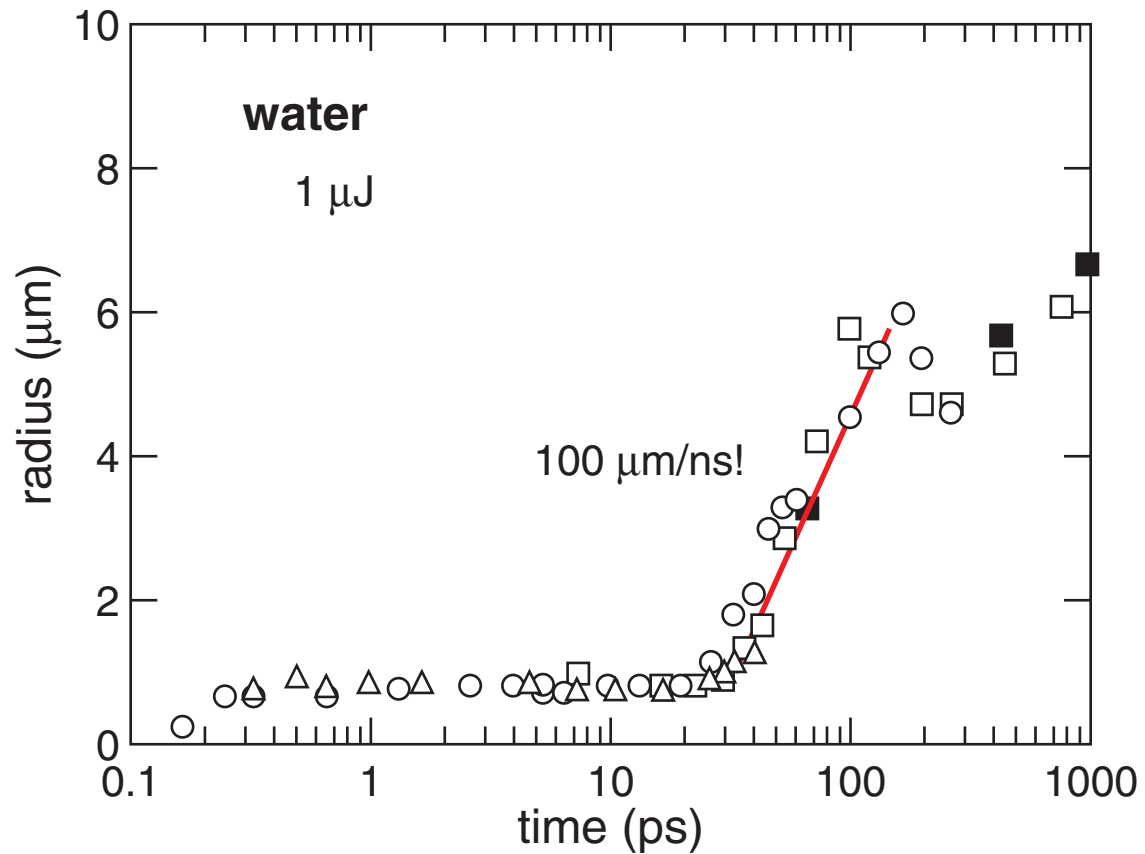


**signal proportional to area of scatterer**

# Dynamics



# Dynamics



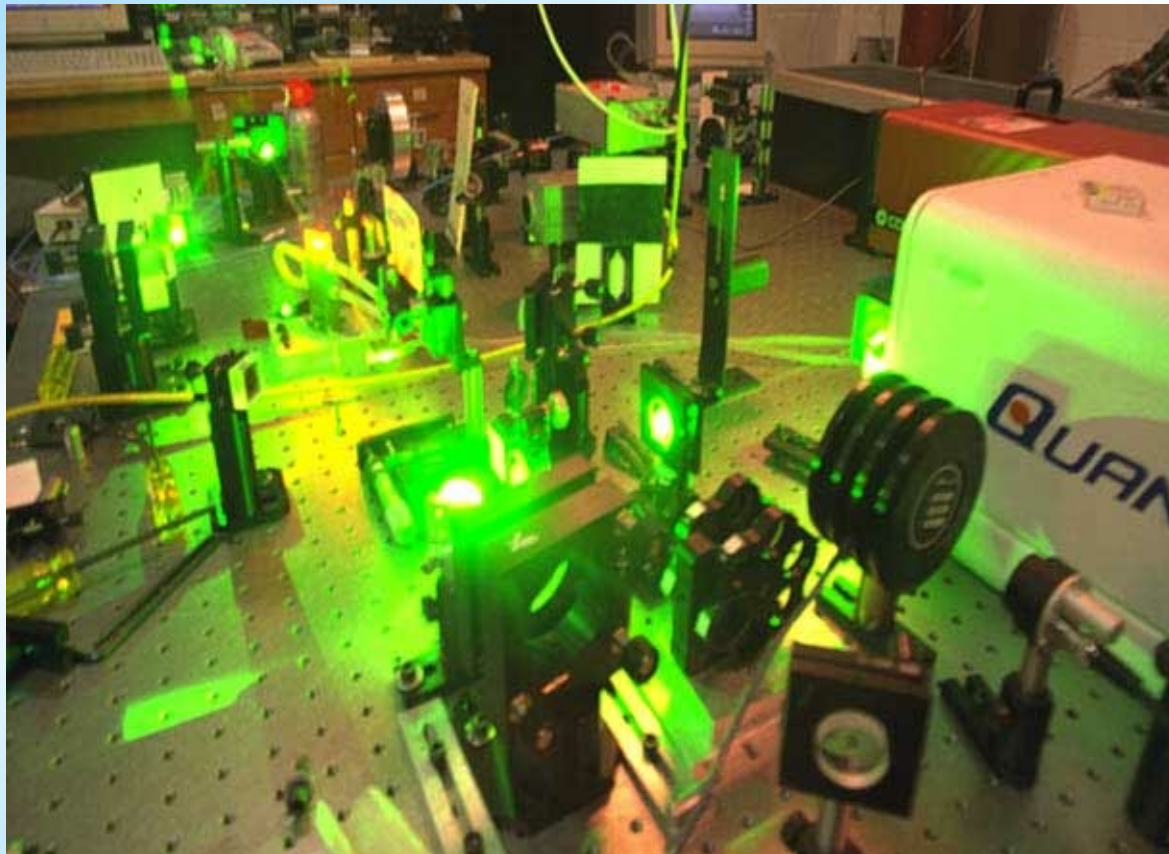


# *Conclusions*

- ▶ **submicron-scale bulk micromachining**
- ▶ **weak bandgap and wavelength dependence**
- ▶ **only a few nanojoules required**

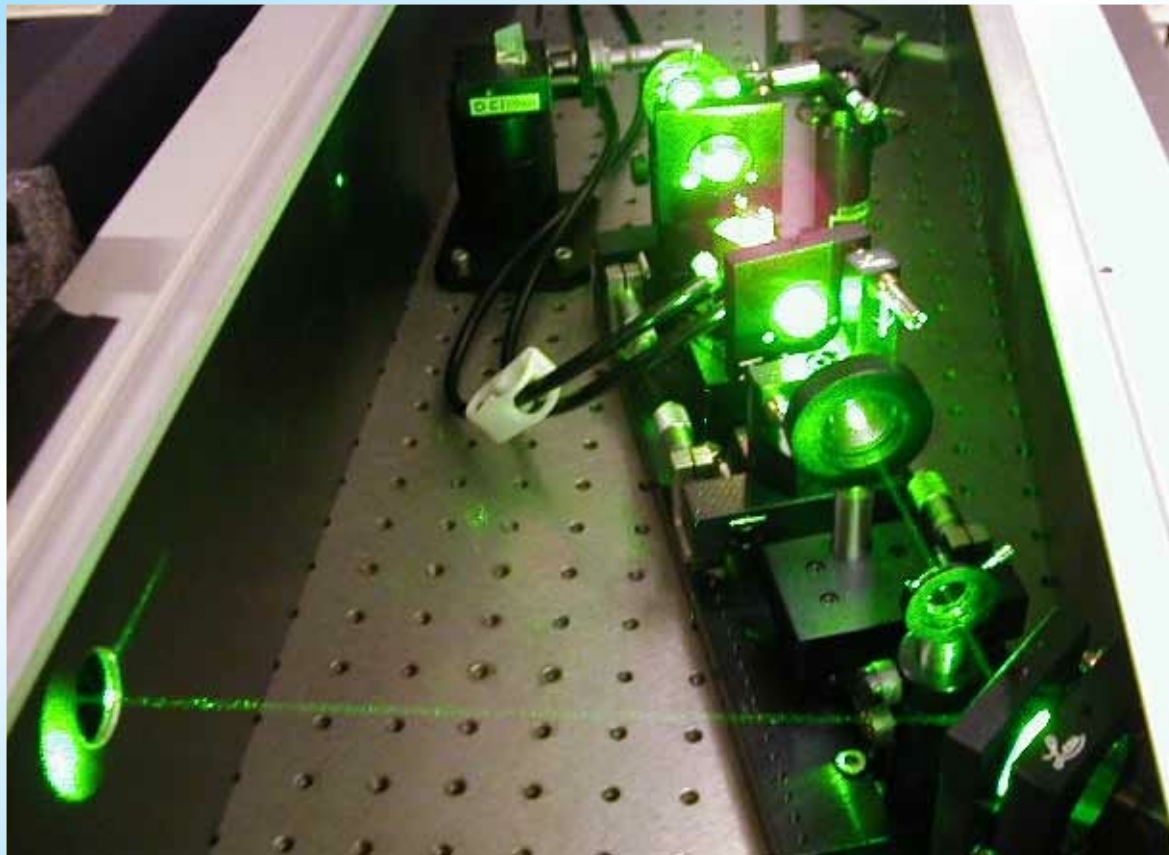
# *Laser micromachining simplified*

**5-nJ threshold: unamplified micromachining**



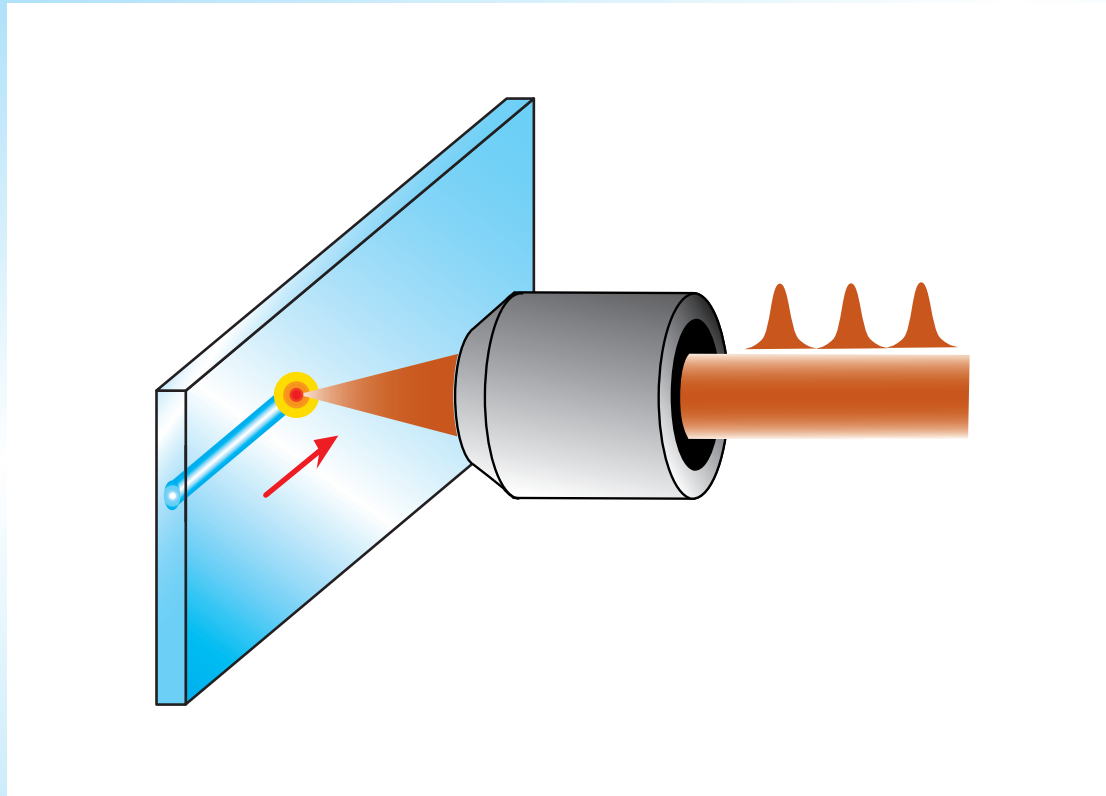
# *Laser micromachining simplified*

**5-nJ threshold: unamplified micromachining**



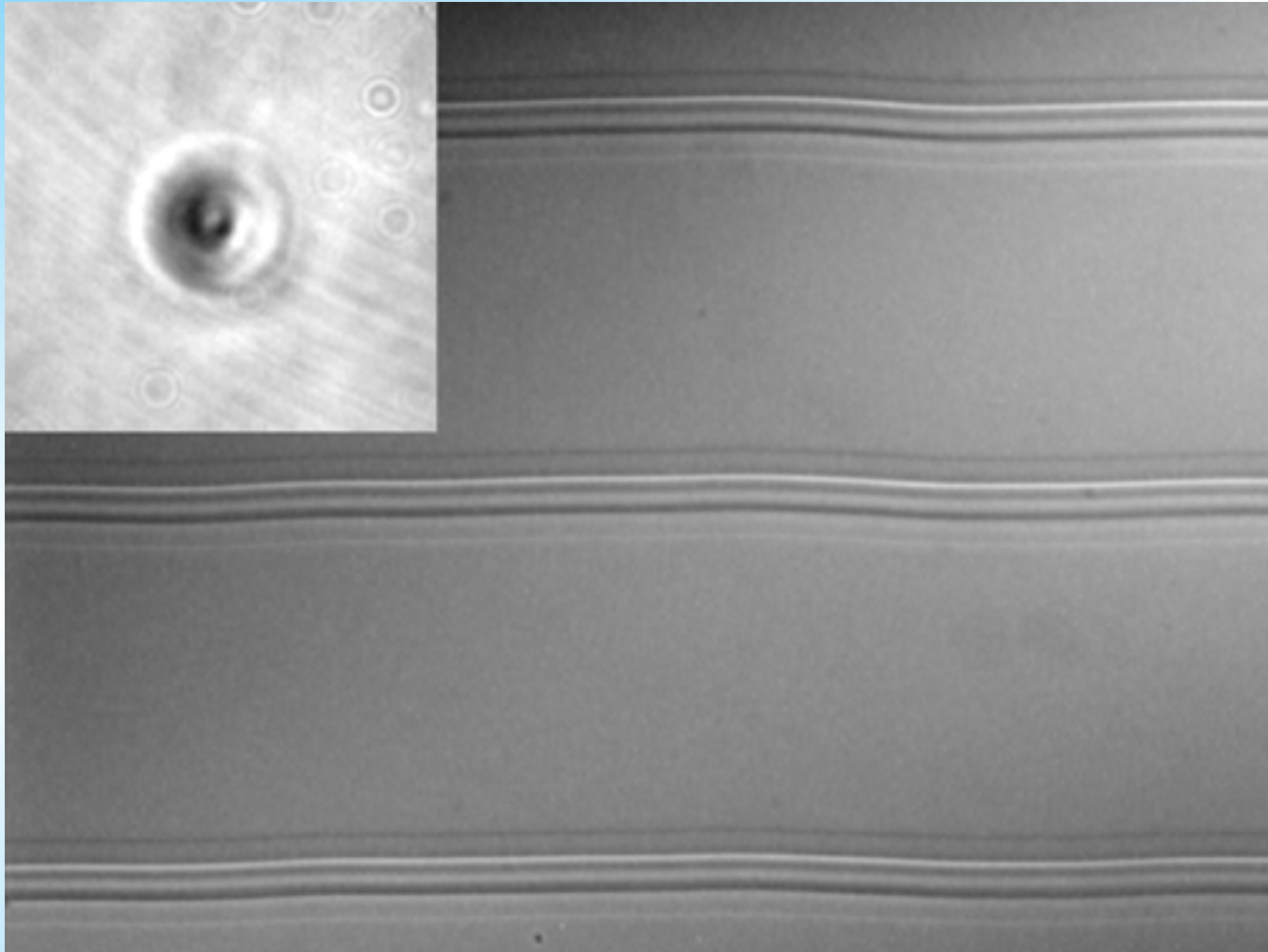
# *Laser micromachining simplified*

## **waveguide machining**



# *Laser micromachining simplified*

## **waveguide machining**



# *Future applications*

- ▶ **Photonic devices**

## *Future applications*

- ▶ **Photonic devices**
- ▶ **Wavelength-selective splitter**

## *Future applications*

**wavelength selective splitter**





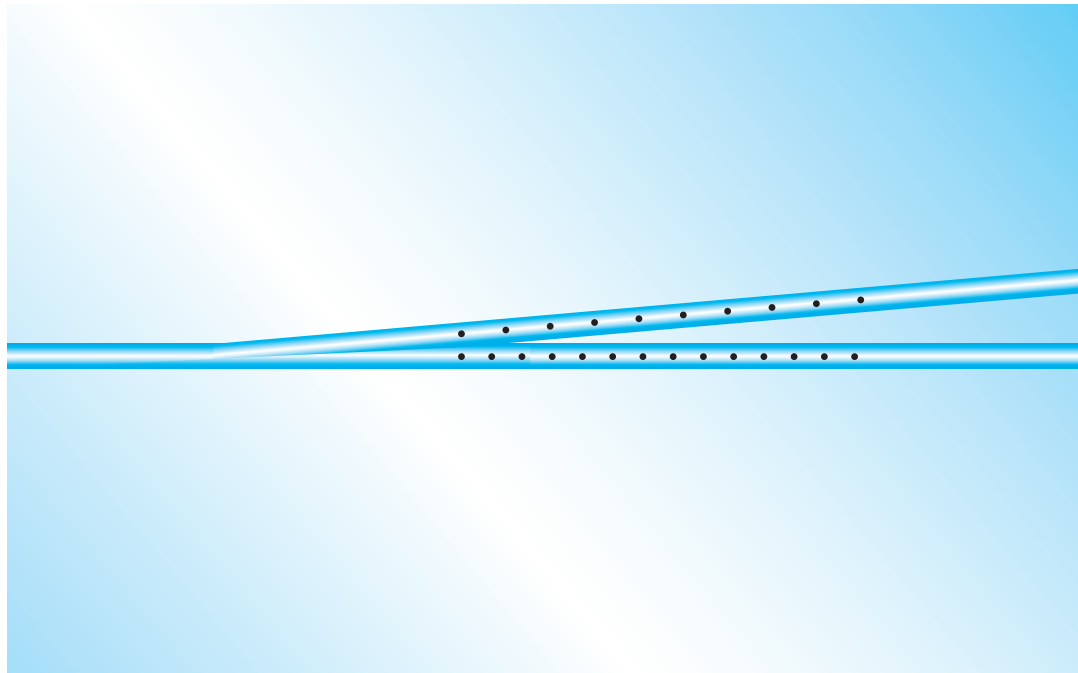
## *Future applications*

**wavelength selective splitter**



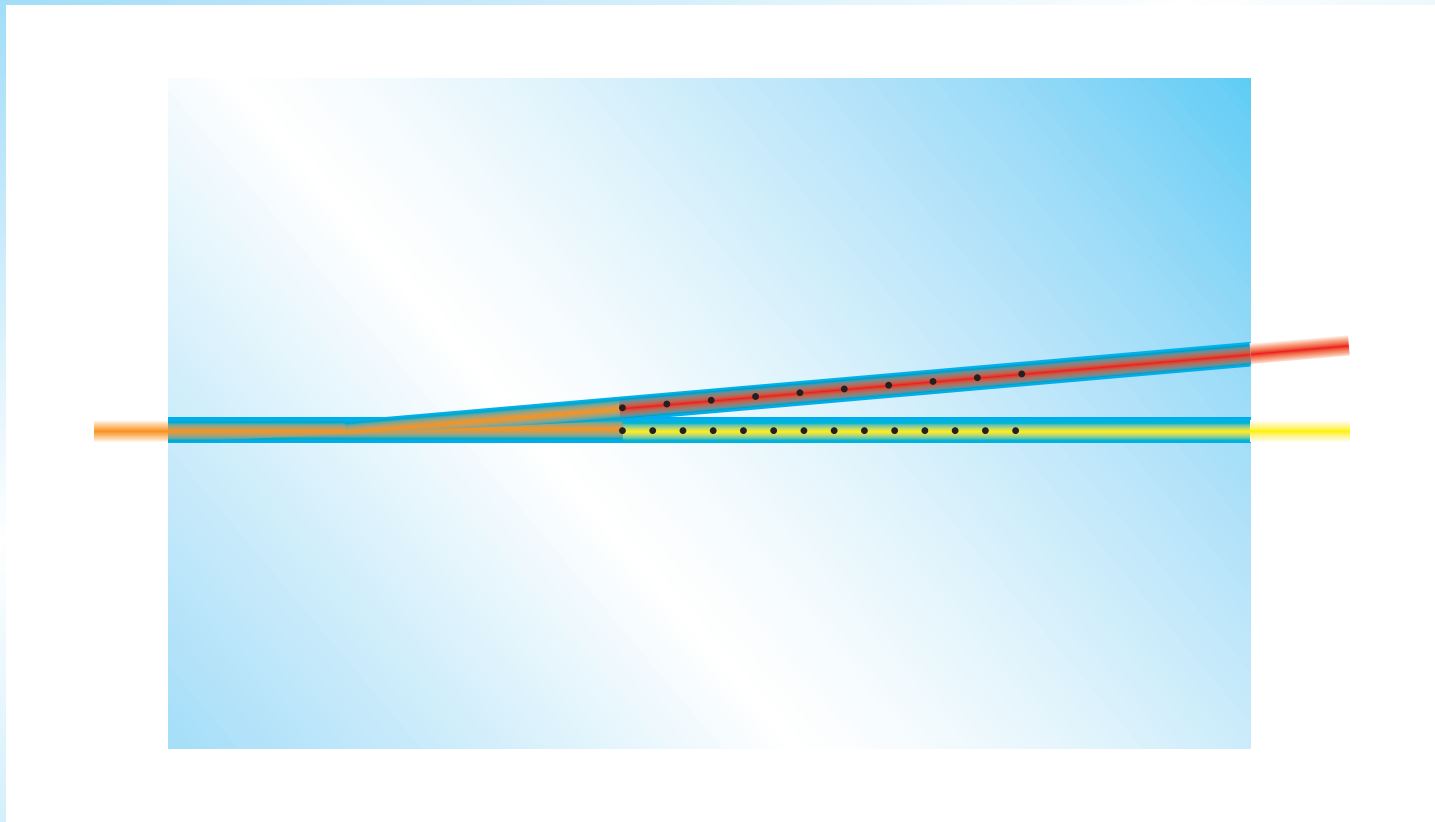
# *Future applications*

## wavelength selective splitter



# *Future applications*

## wavelength selective splitter



## *Future applications*

- ▶ **Photonic devices**
- ▶ **Wavelength-selective splitter**
- ▶ **Photonic bandgap materials**

# *Open questions*

- ▶ **Propagation of pulses**
- ▶ **Mechanisms**

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**W. Leight**

**Carl Zeiss, Inc**

**For a copy of this talk and  
additional information, see:**

**<http://mazur-www.harvard.edu>**